

Product Overview

The NSI823x devices are high reliability triple-channel digital isolators. The NSI823x device is safety certified by UL1577 support several insulation withstand voltages (3kVrms, 3.75kVrms, 8kVrms), while providing high electromagnetic immunity and low emissions at low power consumption. The data rate of the NSI823x is up to 150Mbps, and the common-mode transient immunity (CMTI) is up to 250kV/us. The NSI823x device provides digital channel direction configuration and the default output level configuration when the input power is lost. Wide supply voltage of the NSI823x device supports to connect with most digital interface directly, easy to do the level shift. High system level EMC performance enhance reliability and stability of use.

Key Features

- Up to 8000V<sub>rms</sub> Insulation voltage
- Date rate: DC to 150Mbps
- Power supply voltage: 2.5V to 5.5V
- High CMTI: 250kV/us
- Chip level ESD: HBM: ±8kV
- Robust Electromagnetic Compatibility (EMC)
  - System-Level ESD, EFT, and Surge Immunity
  - Low Emissions
- Default output high level or low level option
- Low power consumption: 1.5mA/ch (1 Mbps)
- Low propagation delay: <15ns
- Operation temperature: -55°C~125°C
- RoHS-compliant packages:
  - SOP16(150mil)
  - SOP16(600mil)
  - SSOP16

Safety Regulatory Approvals

- UL recognition: up to 8000V<sub>rms</sub> for 1 minute per UL1577
- CQC certification per GB4943.1
- CSA component notice 5A
- DIN EN IEC 60747-17 (VDE 0884-17)

Applications

- Industrial automation system
- Isolated SPI, RS232, RS485
- General-purpose multichannel isolation
- Motor control

Device Information

| Part Number     | Package       | Body Size        |
|-----------------|---------------|------------------|
| NSI823xNx-DSPNR | SOP16(150mil) | 9.90mm x 3.90mm  |
| NSI823xSx -DSSR | SSOP16        | 4.90mm × 3.90mm  |
| NSI823xWx-DSWWR | SOP16(600mil) | 10.52mm × 14.0mm |

Functional Block Diagrams

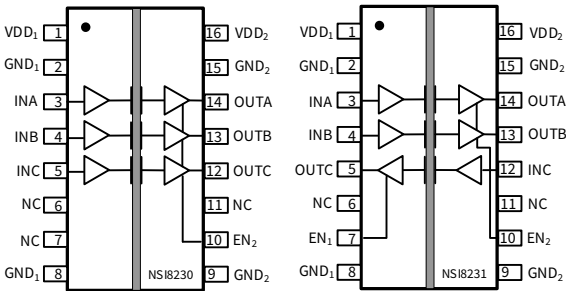


Figure 1. NSI823x Block Diagram

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## 1. Pin Configuration and Functions

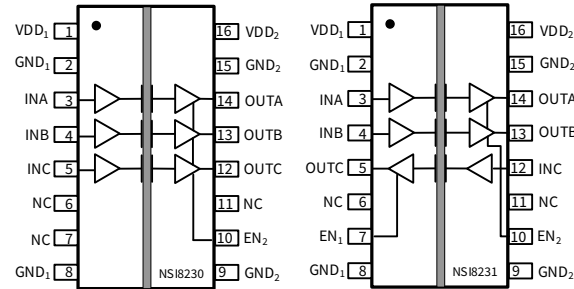


Figure 1.1 NSI823x Package

Table 1.1 NSI823x Pin Configuration and Description

| NSI8230<br>PIN NO. | NSI8231<br>PIN NO. | SYMBOL              | FUNCTION                                                                                                                                                                                                                |
|--------------------|--------------------|---------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1                  | 1                  | VDD <sub>1</sub>    | Power Supply for Isolator Side 1                                                                                                                                                                                        |
| 2                  | 2                  | GND <sub>1</sub>    | Ground 1, the ground reference for Isolator Side 1                                                                                                                                                                      |
| 3                  | 3                  | INA                 | Logic Input A                                                                                                                                                                                                           |
| 4                  | 4                  | INB                 | Logic Input B                                                                                                                                                                                                           |
| 5                  | 12                 | INC                 | Logic Input C                                                                                                                                                                                                           |
| 6                  | 6                  | NC                  | No Connection.                                                                                                                                                                                                          |
| 7                  | 7                  | NC /EN <sub>1</sub> | No Connection. Or Output Enable 1. Active high logic input. When EN <sub>1</sub> is high or NC, the output of Side 1 is enabled. When EN <sub>1</sub> is low, the output of Side 1 is disabled to high impedance state. |
| 8                  | 8                  | GND <sub>1</sub>    | Ground 1, the ground reference for Isolator Side 1                                                                                                                                                                      |
| 9                  | 9                  | GND <sub>2</sub>    | Ground 2, the ground reference for Isolator Side 2                                                                                                                                                                      |
| 10                 | 10                 | EN <sub>2</sub>     | Output Enable 2. Active high logic input. When EN <sub>2</sub> is high or NC, the output of Side 2 is enabled. When EN <sub>2</sub> is low, the output of Side 2 is disabled to high impedance state.                   |
| 11                 | 11                 | NC                  | No Connection.                                                                                                                                                                                                          |
| 12                 | 5                  | OUTC                | Logic Output C                                                                                                                                                                                                          |
| 13                 | 13                 | OUTB                | Logic Output B                                                                                                                                                                                                          |
| 14                 | 14                 | OUTA                | Logic Output A                                                                                                                                                                                                          |
| 15                 | 15                 | GND <sub>2</sub>    | Ground 2, the ground reference for Isolator Side 2                                                                                                                                                                      |
| 16                 | 16                 | VDD <sub>2</sub>    | Power Supply for Isolator Side 2                                                                                                                                                                                        |

## 2. Absolute Maximum Ratings

| Parameters                         | Symbol                                | Min  | Typ | Max     | Unit | Comments                                                                          |
|------------------------------------|---------------------------------------|------|-----|---------|------|-----------------------------------------------------------------------------------|
| Power Supply Voltage               | VDD1, VDD2                            | -0.5 |     | 6.5     | V    |                                                                                   |
| Maximum Input Voltage              | VINA, VINB, VINC                      | -0.4 |     | VDD+0.4 | V    | The maximum voltage must not exceed 6.5V                                          |
| Maximum Output Voltage             | VOUTA, VOUTB, VOUTC                   | -0.4 |     | VDD+0.4 | V    | The maximum voltage must not exceed 6.5V                                          |
| Maximum Input/Output Pulse Voltage | VINA, VINB, VINC, VOUTA, VOUTB, VOUTC | -0.8 |     | VDD+0.8 | V    | Pulse width should be less than 100ns, and the duty cycle should be less than 10% |
| Output current                     | I <sub>o</sub>                        | -15  |     | 15      | mA   |                                                                                   |
| Operating Temperature              | T <sub>opr</sub>                      | -55  |     | 125     | °C   |                                                                                   |
| Junction Temperature               | T <sub>j</sub>                        |      |     | 150     | °C   |                                                                                   |
| Storage Temperature                | T <sub>stg</sub>                      | -65  |     | 150     | °C   |                                                                                   |
| Electrostatic discharge            | HBM                                   |      |     | ±8000   | V    |                                                                                   |
|                                    | CDM                                   |      |     | ±2000   | V    |                                                                                   |

## 3. Recommended Operating Conditions

| Parameters               | Symbol           | min | typ | max | unit |
|--------------------------|------------------|-----|-----|-----|------|
| Power Supply Voltage     | VDD1, VDD2       | 2.5 |     | 5.5 | V    |
| Operating Temperature    | T <sub>opr</sub> | -55 |     | 125 | °C   |
| High Level Input Voltage | V <sub>IH</sub>  | 2   |     |     | V    |
| Low Level Input Voltage  | V <sub>IL</sub>  |     |     | 0.8 | V    |
| Data rate                | DR               |     |     | 150 | Mbps |

## 4. Thermal Information

| Parameters                            | Symbol           | SSOP16 | SOP16(150mil) | SOP16(600mil) | Unit |
|---------------------------------------|------------------|--------|---------------|---------------|------|
| IC Junction-to-Air Thermal Resistance | R <sub>θJA</sub> | 140    | 78.9          | 78.9          | °C/W |

| Parameters                                | Symbol                | SSOP16 | SOP16(150mil) | SOP16(600mil) | Unit |
|-------------------------------------------|-----------------------|--------|---------------|---------------|------|
| Junction-to-case (top) thermal resistance | $R_{\theta JC (top)}$ | 54.4   | 41.1          | 41.1          | °C/W |
| Junction-to-board thermal resistance      | $R_{\theta JB}$       | 51.9   | 49.5          | 49.5          | °C/W |

## 5. Specifications

### 5.1. Electrical Characteristics

(VDD1=2.5V~5.5V, VDD2=2.5V~5.5V, Ta=-55°C to 125°C. Unless otherwise noted, Typical values are at VDD1 = 5V, VDD2 = 5V, Ta = 25°C)

| Parameters                         | Symbol              | Min     | Typ  | Max | Unit  | Comments                                               |
|------------------------------------|---------------------|---------|------|-----|-------|--------------------------------------------------------|
| Power on Reset                     | VDD <sub>POR</sub>  | 2       | 2.2  | 2.4 | V     | POR threshold as during power-up                       |
|                                    | VDD <sub>HYS</sub>  |         | 0.1  |     | V     | POR threshold Hysteresis                               |
| Rising input switching threshold   | V <sub>IT+</sub>    |         | 1.6  | 2   | V     |                                                        |
| Falling input switching threshold  | V <sub>IT-</sub>    | 0.8     | 1.2  |     | V     |                                                        |
| Input threshold voltage hysteresis | V <sub>I(HYS)</sub> |         | 0.4  |     | V     |                                                        |
| High Level Output Voltage          | V <sub>OH</sub>     | VDD-0.4 |      |     | V     | I <sub>OH</sub> = - 4mA                                |
| Low Level Output Voltage           | V <sub>OL</sub>     |         |      | 0.4 | V     | I <sub>OL</sub> = 4mA                                  |
| Output Impedance                   | R <sub>out</sub>    |         | 50   |     | ohm   |                                                        |
| Input Pull high or low Current     | I <sub>pull</sub>   |         | 8    | 15  | uA    |                                                        |
| Start Up Time after POR            | t <sub>rs</sub>     |         | 10   |     | us    |                                                        |
| Common Mode Transient Immunity     | CMTI                | ±200    | ±250 |     | kV/us | See <a href="#">Figure 5.9</a> , C <sub>L</sub> = 15pF |

## 5.2. Supply Current Characteristics – 5V Supply

(VDD1=5V± 10%, VDD2=5V± 10%, Ta=-55°C to 125°C. Unless otherwise noted, Typical values are at **VDD1 = 5V, VDD2 = 5V**, Ta = 25°C)

| Parameters     | Symbol                  | Min | Typ.  | Max   | Unit | Comments                                                              |
|----------------|-------------------------|-----|-------|-------|------|-----------------------------------------------------------------------|
| Supply current | NSI8230                 |     |       |       |      |                                                                       |
|                | I <sub>DD1</sub> (Q0)   |     | 1.24  | 2.04  | mA   | All Input 0V for NSI8230x0 Or<br>All Input at supply for<br>NSI8230x1 |
|                | I <sub>DD2</sub> (Q0)   |     | 2.94  | 4.84  | mA   |                                                                       |
|                | I <sub>DD1</sub> (Q1)   |     | 4.25  | 7.02  | mA   | All Input at supply for<br>NSI8230x0<br>Or All Input 0V for NSI8230x1 |
|                | I <sub>DD2</sub> (Q1)   |     | 3.00  | 4.95  | mA   |                                                                       |
|                | I <sub>DD1</sub> (1M)   |     | 2.43  | 4.00  | mA   | All Input with 1Mbps,<br>C <sub>L</sub> =15pF                         |
|                | I <sub>DD2</sub> (1M)   |     | 2.45  | 4.27  | mA   |                                                                       |
|                | I <sub>DD1</sub> (10M)  |     | 2.92  | 4.82  | mA   | All Input with 10Mbps,<br>C <sub>L</sub> =15pF                        |
|                | I <sub>DD2</sub> (10M)  |     | 3.06  | 5.99  | mA   |                                                                       |
|                | I <sub>DD1</sub> (100M) |     | 3.97  | 7.93  | mA   | All Input with 100Mbps,<br>C <sub>L</sub> =15pF                       |
|                | I <sub>DD2</sub> (100M) |     | 12.47 | 29.28 | mA   |                                                                       |
|                | NSI8231                 |     |       |       |      |                                                                       |
|                | I <sub>DD1</sub> (Q0)   |     | 1.66  | 2.74  | mA   | All Input 0V for NSI8231x0 Or<br>All Input at supply for<br>NSI8231x1 |
|                | I <sub>DD2</sub> (Q0)   |     | 2.51  | 4.14  | mA   |                                                                       |
|                | I <sub>DD1</sub> (Q1)   |     | 3.69  | 6.09  | mA   | All Input at supply for<br>NSI8231x0<br>Or All Input 0V for NSI8231x1 |
|                | I <sub>DD2</sub> (Q1)   |     | 3.56  | 5.87  | mA   |                                                                       |
|                | I <sub>DD1</sub> (1M)   |     | 2.31  | 3.81  | mA   | All Input with 1Mbps,<br>C <sub>L</sub> =15pF                         |
|                | I <sub>DD2</sub> (1M)   |     | 2.40  | 4.17  | mA   |                                                                       |
|                | I <sub>DD1</sub> (10M)  |     | 2.75  | 4.53  | mA   | All Input with 10Mbps,<br>C <sub>L</sub> =15pF                        |
|                | I <sub>DD2</sub> (10M)  |     | 3.40  | 5.61  | mA   |                                                                       |
|                | I <sub>DD1</sub> (100M) |     | 6.69  | 13.38 | mA   | All Input with 100Mbps,<br>C <sub>L</sub> = 15pF                      |
|                | I <sub>DD2</sub> (100M) |     | 12.47 | 24.94 | mA   |                                                                       |

### 5.3. Supply Current Characteristics –3.3V Supply

(VDD1=3.3V± 10%, VDD2=3.3V± 10%, Ta=-55°C to 125°C. Unless otherwise noted, Typical values are at VDD1 = 3.3V, VDD2 = 3.3V, Ta = 25°C)

| Parameters     | Symbol                  | Min | Typ.  | Max   | Unit | Comments                                                              |
|----------------|-------------------------|-----|-------|-------|------|-----------------------------------------------------------------------|
| Supply current | NSI8230                 |     |       |       |      |                                                                       |
|                | I <sub>DD1</sub> (Q0)   |     | 1.19  | 1.96  | mA   | All Input 0V for NSI8230x0 Or<br>All Input at supply for<br>NSI8230x1 |
|                | I <sub>DD2</sub> (Q0)   |     | 2.87  | 4.74  | mA   |                                                                       |
|                | I <sub>DD1</sub> (Q1)   |     | 4.20  | 6.93  | mA   | All Input at supply for<br>NSI8230x0<br>Or All Input 0V for NSI8230x1 |
|                | I <sub>DD2</sub> (Q1)   |     | 2.93  | 4.83  | mA   |                                                                       |
|                | I <sub>DD1</sub> (1M)   |     | 2.38  | 3.92  | mA   | All Input with 1Mbps,<br>C <sub>L</sub> =15pF                         |
|                | I <sub>DD2</sub> (1M)   |     | 2.37  | 4.14  | mA   |                                                                       |
|                | I <sub>DD1</sub> (10M)  |     | 2.81  | 4.64  | mA   | All Input with 10Mbps,<br>C <sub>L</sub> =15pF                        |
|                | I <sub>DD2</sub> (10M)  |     | 2.66  | 5.27  | mA   |                                                                       |
|                | I <sub>DD1</sub> (100M) |     | 3.30  | 6.59  | mA   | All Input with 100Mbps,<br>C <sub>L</sub> =15pF                       |
|                | I <sub>DD2</sub> (100M) |     | 10.01 | 20.01 | mA   |                                                                       |
|                | NSI8231                 |     |       |       |      |                                                                       |
|                | I <sub>DD1</sub> (Q0)   |     | 1.61  | 2.66  | mA   | All Input 0V for NSI8231x0 Or<br>All Input at supply for<br>NSI8231x1 |
|                | I <sub>DD2</sub> (Q0)   |     | 2.45  | 4.04  | mA   |                                                                       |
|                | I <sub>DD1</sub> (Q1)   |     | 3.64  | 6.00  | mA   | All Input at supply for<br>NSI8231x0<br>Or All Input 0V for NSI8231x1 |
|                | I <sub>DD2</sub> (Q1)   |     | 3.49  | 5.76  | mA   |                                                                       |
|                | I <sub>DD1</sub> (1M)   |     | 2.25  | 3.71  | mA   | All Input with 1Mbps,<br>C <sub>L</sub> =15pF                         |
|                | I <sub>DD2</sub> (1M)   |     | 2.34  | 4.06  | mA   |                                                                       |
|                | I <sub>DD1</sub> (10M)  |     | 2.53  | 4.18  | mA   | All Input with 10Mbps,<br>C <sub>L</sub> =15pF                        |
|                | I <sub>DD2</sub> (10M)  |     | 3.00  | 4.94  | mA   |                                                                       |
|                | I <sub>DD1</sub> (100M) |     | 5.42  | 10.84 | mA   | All Input with 100Mbps,<br>C <sub>L</sub> = 15pF                      |
|                | I <sub>DD2</sub> (100M) |     | 10.01 | 20.01 | mA   |                                                                       |

#### 5.4. Supply Current Characteristics–2.5V Supply

(VDD1=2.5V± 10%, VDD2=2.5V± 10%, Ta=-55°C to 125°C. Unless otherwise noted, Typical values are at VDD1 = 2.5V, VDD2 = 2.5V, Ta = 25°C)

| Parameters     | Symbol                  | Min | Typ. | Max   | Unit | Comments                                                              |
|----------------|-------------------------|-----|------|-------|------|-----------------------------------------------------------------------|
| Supply current | NSI8230                 |     |      |       |      |                                                                       |
|                | I <sub>DD1</sub> (Q0)   |     | 1.17 | 1.92  | mA   | All Input 0V for NSI8230x0 Or<br>All Input at supply for<br>NSI8230x1 |
|                | I <sub>DD2</sub> (Q0)   |     | 2.83 | 4.66  | mA   |                                                                       |
|                | I <sub>DD1</sub> (Q1)   |     | 4.14 | 6.83  | mA   | All Input at supply for<br>NSI8230x0<br>Or All Input 0V for NSI8230x1 |
|                | I <sub>DD2</sub> (Q1)   |     | 2.87 | 4.74  | mA   |                                                                       |
|                | I <sub>DD1</sub> (1M)   |     | 2.30 | 3.80  | mA   | All Input with 1Mbps,<br>C <sub>L</sub> =15pF                         |
|                | I <sub>DD2</sub> (1M)   |     | 2.31 | 4.05  | mA   |                                                                       |
|                | I <sub>DD1</sub> (10M)  |     | 2.70 | 4.46  | mA   | All Input with 10Mbps,<br>C <sub>L</sub> =15pF                        |
|                | I <sub>DD2</sub> (10M)  |     | 2.46 | 4.90  | mA   |                                                                       |
|                | I <sub>DD1</sub> (100M) |     | 2.85 | 5.70  | mA   | All Input with 100Mbps,<br>C <sub>L</sub> =15pF                       |
|                | I <sub>DD2</sub> (100M) |     | 8.22 | 16.44 | mA   |                                                                       |
|                | NSI8231                 |     |      |       |      |                                                                       |
|                | I <sub>DD1</sub> (Q0)   |     | 1.58 | 2.61  | mA   | All Input 0V for NSI8231x0 Or<br>All Input at supply for<br>NSI8231x1 |
|                | I <sub>DD2</sub> (Q0)   |     | 2.41 | 3.98  | mA   |                                                                       |
|                | I <sub>DD1</sub> (Q1)   |     | 3.58 | 5.90  | mA   | All Input at supply for<br>NSI8231x0<br>Or All Input 0V for NSI8231x1 |
|                | I <sub>DD2</sub> (Q1)   |     | 3.43 | 5.67  | mA   |                                                                       |
|                | I <sub>DD1</sub> (1M)   |     | 2.18 | 3.60  | mA   | All Input with 1Mbps,<br>C <sub>L</sub> =15pF                         |
|                | I <sub>DD2</sub> (1M)   |     | 2.29 | 3.95  | mA   |                                                                       |
|                | I <sub>DD1</sub> (10M)  |     | 2.39 | 3.95  | mA   | All Input with 10Mbps,<br>C <sub>L</sub> =15pF                        |
|                | I <sub>DD2</sub> (10M)  |     | 2.80 | 4.61  | mA   |                                                                       |
|                | I <sub>DD1</sub> (100M) |     | 4.53 | 9.05  | mA   | All Input with 100Mbps,<br>C <sub>L</sub> = 15pF                      |
|                | I <sub>DD2</sub> (100M) |     | 8.22 | 16.44 | mA   |                                                                       |

### 5.5. Switching Characteristics - 5V Supply

(VDD1=5V± 10%, VDD2=5V± 10%, Ta=-55°C to 125°C. Unless otherwise noted, Typical values are at VDD1 = 5V, VDD2 = 5V, Ta = 25°C)

| Parameters                                                     | Symbol               | Min | Typ. | Max | Unit | Comments                                                                   |
|----------------------------------------------------------------|----------------------|-----|------|-----|------|----------------------------------------------------------------------------|
| Data Rate                                                      | DR                   | 0   |      | 150 | Mbps |                                                                            |
| Minimum Pulse Width                                            | PW                   |     |      | 5.0 | ns   |                                                                            |
| Propagation Delay                                              | t <sub>PLH</sub>     | 2.5 | 6.54 | 15  | ns   | See <a href="#">Figure 5.7</a> , C <sub>L</sub> = 15pF                     |
|                                                                | t <sub>PHL</sub>     | 2.5 | 8.30 | 15  | ns   | See <a href="#">Figure 5.7</a> , C <sub>L</sub> = 15pF                     |
| Pulse Width Distortion<br> t <sub>PHL</sub> - t <sub>PLH</sub> | PWD                  |     |      | 5.0 | ns   | See <a href="#">Figure 5.7</a> , C <sub>L</sub> = 15pF                     |
| Rising Time                                                    | t <sub>r</sub>       |     |      | 5.0 | ns   | See <a href="#">Figure 5.7</a> , C <sub>L</sub> = 15pF                     |
| Falling Time                                                   | t <sub>f</sub>       |     |      | 5.0 | ns   | See <a href="#">Figure 5.7</a> , C <sub>L</sub> = 15pF                     |
| Peak Eye Diagram Jitter                                        | t <sub>JIT(PK)</sub> |     | 350  |     | ps   |                                                                            |
| Channel-to-Channel Delay Skew                                  | t <sub>SK(c2c)</sub> |     |      | 2.5 | ns   |                                                                            |
| Part-to-Part Delay Skew                                        | t <sub>SK(p2p)</sub> |     |      | 5.0 | ns   |                                                                            |
| Disable high to Tri-State                                      | t <sub>PHZ</sub>     |     | 10.0 | 30  | ns   | See <a href="#">Figure 5.8</a> , C <sub>L</sub> = 15pF, R <sub>L</sub> =1k |
| Enable to Data high Valid                                      | t <sub>PZH</sub>     |     | 8.3  | 30  | ns   | See <a href="#">Figure 5.8</a> , C <sub>L</sub> = 15pF, R <sub>L</sub> =1k |
| Disable low to Tri-State                                       | t <sub>PLZ</sub>     |     | 10.2 | 30  | ns   | See <a href="#">Figure 5.8</a> , C <sub>L</sub> = 15pF, R <sub>L</sub> =1k |
| Enable to Data low Valid                                       | t <sub>PZL</sub>     |     | 8.6  | 30  | ns   | See <a href="#">Figure 5.8</a> , C <sub>L</sub> = 15pF, R <sub>L</sub> =1k |

### 5.6. Switching Characteristics - 3.3V Supply

(VDD1=3.3V± 10%, VDD2=3.3V± 10%, Ta=-55°C to 125°C. Unless otherwise noted, Typical values are at VDD1 = 3.3V, VDD2 = 3.3V, Ta = 25°C)

| Parameters             | Symbol           | Min | Typ | Max | Unit | Comments                                               |
|------------------------|------------------|-----|-----|-----|------|--------------------------------------------------------|
| Data Rate              | DR               | 0   |     | 150 | Mbps |                                                        |
| Minimum Pulse Width    | PW               |     |     | 5.0 | ns   |                                                        |
| Propagation Delay      | t <sub>PLH</sub> | 2.5 | 7.5 | 15  | ns   | See <a href="#">Figure 5.7</a> , C <sub>L</sub> = 15pF |
|                        | t <sub>PHL</sub> | 2.5 | 8.7 | 15  | ns   | See <a href="#">Figure 5.7</a> , C <sub>L</sub> = 15pF |
| Pulse Width Distortion | PWD              |     |     | 5.0 | ns   | See <a href="#">Figure 5.7</a> , C <sub>L</sub> = 15pF |

| Parameters                    | Symbol        | Min | Typ  | Max | Unit | Comments                                                 |
|-------------------------------|---------------|-----|------|-----|------|----------------------------------------------------------|
| $ t_{PHL} - t_{PLH} $         |               |     |      |     |      |                                                          |
| Rising Time                   | $t_r$         |     |      | 5.0 | ns   | See <a href="#">Figure 5.7</a> , $C_L = 15pF$            |
| Falling Time                  | $t_f$         |     |      | 5.0 | ns   | See <a href="#">Figure 5.7</a> , $C_L = 15pF$            |
| Peak Eye Diagram Jitter       | $t_{JIT}(PK)$ |     | 350  |     | ps   |                                                          |
| Channel-to-Channel Delay Skew | $t_{SK}(c2c)$ |     |      | 2.5 | ns   |                                                          |
| Part-to-Part Delay Skew       | $t_{SK}(p2p)$ |     |      | 5.0 | ns   |                                                          |
| Disable high to Tri-State     | $t_{PHZ}$     |     | 11.6 | 30  | ns   | See <a href="#">Figure 5.8</a> , $C_L = 15pF$ , $R_L=1k$ |
| Enable to Data high Valid     | $t_{PZH}$     |     | 11.7 | 30  | ns   | See <a href="#">Figure 5.8</a> , $C_L = 15pF$ , $R_L=1k$ |
| Disable low to Tri-State      | $t_{PLZ}$     |     | 14.5 | 30  | ns   | See <a href="#">Figure 5.8</a> , $C_L = 15pF$ , $R_L=1k$ |
| Enable to Data low Valid      | $t_{PZL}$     |     | 11.8 | 30  | ns   | See <a href="#">Figure 5.8</a> , $C_L = 15pF$ , $R_L=1k$ |

### 5.7. Switching Characteristics - 2.5V Supply

(VDD1=2.5V± 10%, VDD2=2.5V± 10%, Ta=-55°C to 125°C. Unless otherwise noted, Typical values are at VDD1 = 2.5V, VDD2 = 2.5V, Ta = 25°C)

| Parameters                                      | Symbol        | Min | Typ  | Max | Unit | Comments                                                 |
|-------------------------------------------------|---------------|-----|------|-----|------|----------------------------------------------------------|
| Data Rate                                       | DR            | 0   |      | 150 | Mbps |                                                          |
| Minimum Pulse Width                             | PW            |     |      | 5.0 | ns   |                                                          |
| Propagation Delay                               | $t_{PLH}$     | 2.5 | 9.0  | 15  | ns   | See <a href="#">Figure 5.7</a> , $C_L = 15pF$            |
|                                                 | $t_{PHL}$     | 2.5 | 9.3  | 15  | ns   | See <a href="#">Figure 5.7</a> , $C_L = 15pF$            |
| Pulse Width Distortion<br>$ t_{PHL} - t_{PLH} $ | PWD           |     |      | 5.0 | ns   | See <a href="#">Figure 5.7</a> , $C_L = 15pF$            |
| Rising Time                                     | $t_r$         |     |      | 5.0 | ns   | See <a href="#">Figure 5.7</a> , $C_L = 15pF$            |
| Falling Time                                    | $t_f$         |     |      | 5.0 | ns   | See <a href="#">Figure 5.7</a> , $C_L = 15pF$            |
| Peak Eye Diagram Jitter                         | $t_{JIT}(PK)$ |     | 350  |     | ps   |                                                          |
| Channel-to-Channel Delay Skew                   | $t_{SK}(c2c)$ |     |      | 2.5 | ns   |                                                          |
| Part-to-Part Delay Skew                         | $t_{SK}(p2p)$ |     |      | 5.0 | ns   |                                                          |
| Disable high to Tri-State                       | $t_{PHZ}$     |     | 12.2 | 30  | ns   | See <a href="#">Figure 5.8</a> , $C_L = 15pF$ , $R_L=1k$ |
| Enable to Data high Valid                       | $t_{PZH}$     |     | 17.0 | 30  | ns   | See <a href="#">Figure 5.8</a> , $C_L = 15pF$ , $R_L=1k$ |

| Parameters               | Symbol    | Min | Typ  | Max | Unit | Comments                                                               |
|--------------------------|-----------|-----|------|-----|------|------------------------------------------------------------------------|
| Disable low to Tri-State | $t_{PLZ}$ |     | 17.2 | 30  | ns   | See <a href="#">Figure 5.8</a> , $C_L = 15\text{pF}$ , $R_L=1\text{k}$ |
| Enable to Data low Valid | $t_{PZL}$ |     | 17.8 | 30  | ns   | See <a href="#">Figure 5.8</a> , $C_L = 15\text{pF}$ , $R_L=1\text{k}$ |

## 5.8. Typical Performance Characteristics

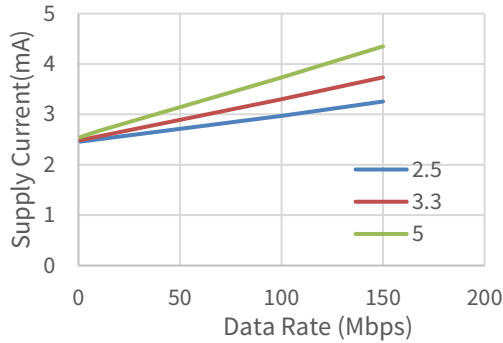


Figure 5.1 NSI8130 VDD1 Supply Current vs Data Rate

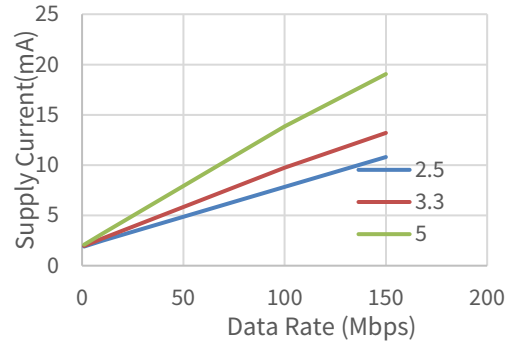


Figure 5.2 NSI8130 VDD2 Supply Current vs Data Rate

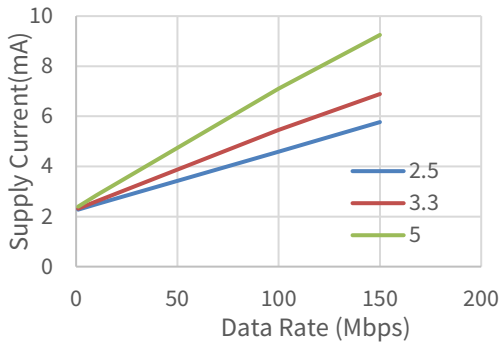


Figure 5.3 NSI8131 VDD1 Supply Current vs Data Rate

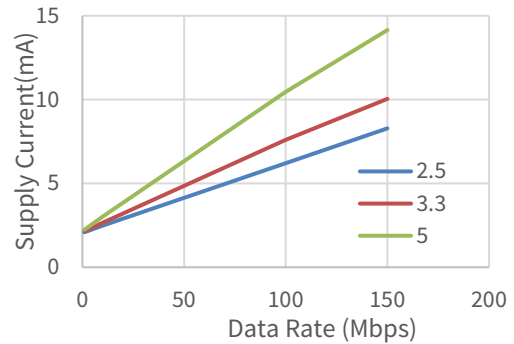


Figure 5.4 NSI8131 VDD2 Supply Current vs Data Rate

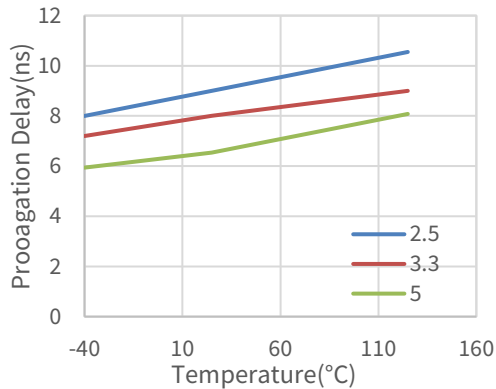


Figure 5.5 Rising Edge Propagation Delay Vs Temp

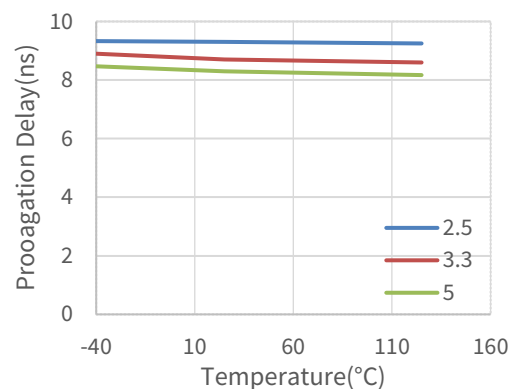
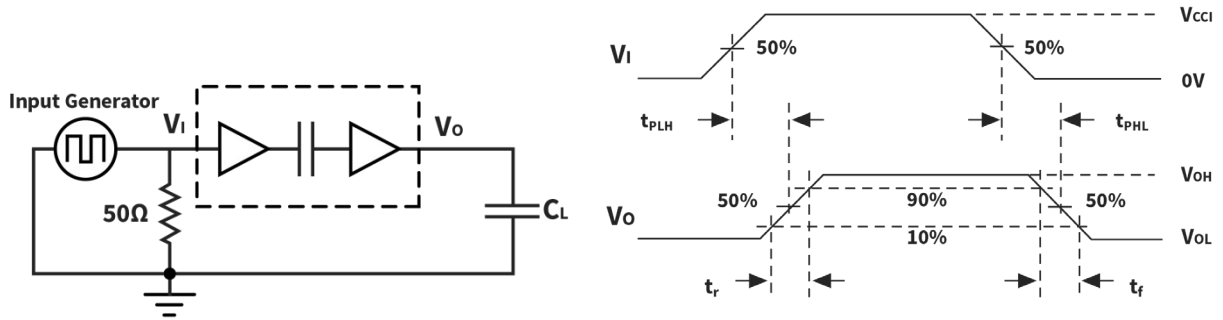


Figure 5.6 Falling Edge Propagation Delay Vs Temp

## 5.9. Parameter Measurement Information



(1) Input Generator Characteristics : PRR  $\leq$  50kHz,  $t_r \leq$  3ns,  $t_f \leq$  3ns, Duty cycle = 50%,  $Z_o = 50 \Omega$ .

Figure 5.7 Switching Characteristics Test Circuit and Waveform

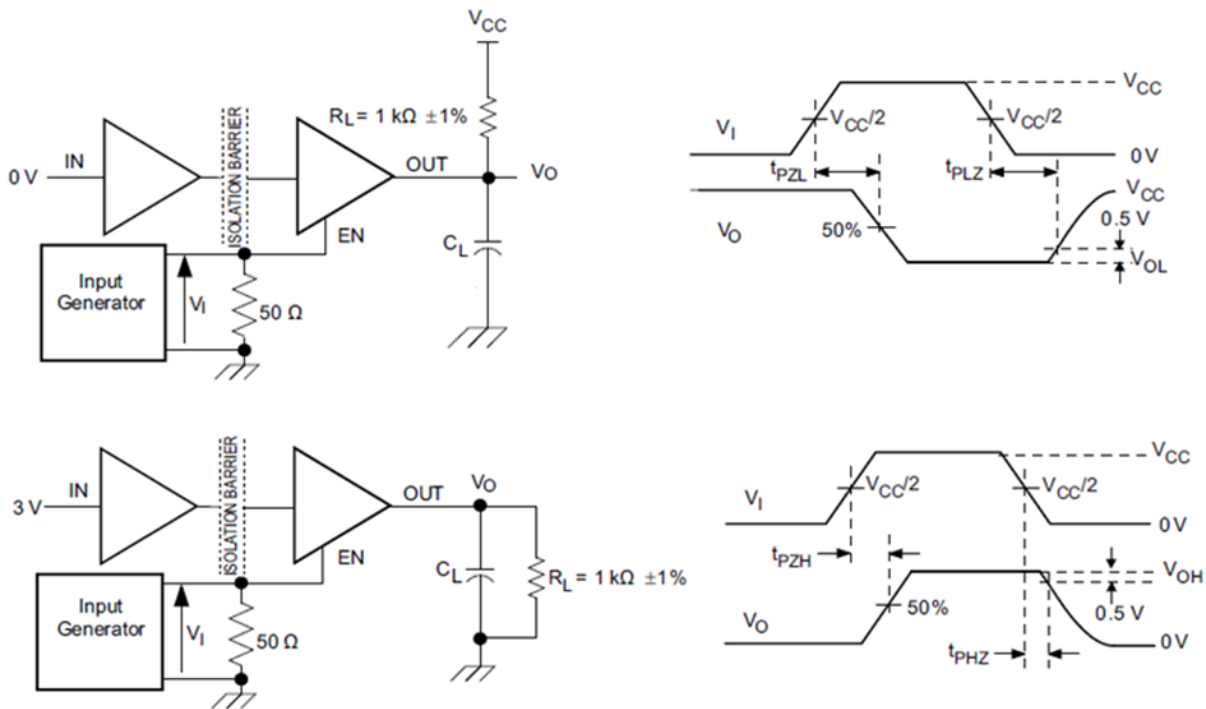


Figure 5.8 Enable/Disable Propagation Delay Time Test Circuit and Waveform

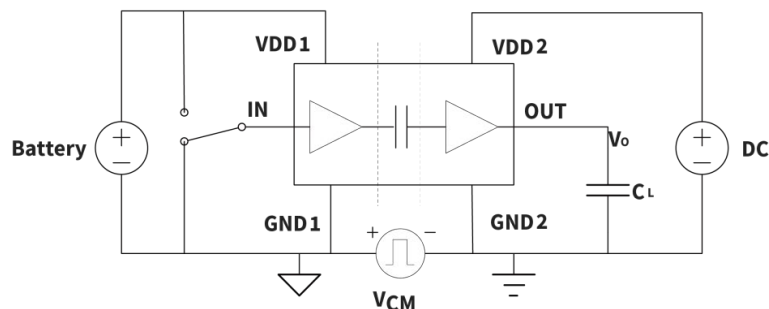


Figure 5.9 Common-Mode Transient Immunity Test Circuit

## 6. high voltage Feature Description

### 6.1. Insulation and Safety Related Specifications

| Parameters                                          | Symbol | Value             |        |                   | Unit | Comments                              |
|-----------------------------------------------------|--------|-------------------|--------|-------------------|------|---------------------------------------|
|                                                     |        | SOP16<br>(600mil) | SSOP16 | SOP16<br>(150mil) |      |                                       |
| Minimum External Clearance                          | CLR    | 15                | 3.9    | 4                 | mm   | IEC 60664-1:2007                      |
| Minimum External Creepage                           | CPG    | 15                | 3.9    | 4                 | mm   | IEC 60664-1:2007                      |
| Distance Through Insulation                         | DTI    | 28                |        |                   | μm   | Distance through insulation           |
| Tracking Resistance<br>(Comparative Tracking Index) | CTI    | >600              | >600   | >600              | V    | DIN EN 60112 (VDE 0303-11); IEC 60112 |
| Material Group                                      |        | I                 | I      | I                 |      | IEC 60664-1                           |

| Description                         | Test Condition                          | Value             |          |                   |
|-------------------------------------|-----------------------------------------|-------------------|----------|-------------------|
|                                     |                                         | SOP16<br>(600mil) | SSOP16   | SOP16<br>(150mil) |
| Overvoltage Category per IEC60664-1 | For Rated Mains Voltage $\leq$ 150Vrms  | I to IV           | I to IV  | I to IV           |
|                                     | For Rated Mains Voltage $\leq$ 300Vrms  | I to IV           | I to III | I to III          |
|                                     | For Rated Mains Voltage $\leq$ 600Vrms  | I to IV           | I to II  | I to II           |
|                                     | For Rated Mains Voltage $\leq$ 1000Vrms | I to IV           | I        | I to II           |
| Climatic Classification             |                                         | 40/125/21         |          |                   |
| Pollution Degree per DIN VDE 0110   |                                         | 2                 |          |                   |

## 6.2. Insulation Characteristics

| Description                          | Test Condition                                                                                                                                                                                                                                      | Symbol     | Value             |        |                   | Unit       |
|--------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------|-------------------|--------|-------------------|------------|
|                                      |                                                                                                                                                                                                                                                     |            | SOP16<br>(600mil) | SSOP16 | SOP16<br>(150mil) |            |
| Maximum repetitive isolation voltage |                                                                                                                                                                                                                                                     | $V_{IORM}$ | 2121              | 565    | 565               | $V_{PEAK}$ |
| Maximum working isolation voltage    | AC Voltage                                                                                                                                                                                                                                          | $V_{IOWM}$ | 1500              | 400    | 400               | $V_{RMS}$  |
|                                      | DC Voltage                                                                                                                                                                                                                                          |            | 2121              | 565    | 565               | $V_{DC}$   |
| Apparent Charge                      | Method a, after Input/output safety test subgroup 2/3,<br>$V_{ini}=V_{IOTM}$ , $t_{ini}=60\text{ s}$ ,<br>$V_{pd(m)}=1.2*V_{IORM}$ , $t_m=10\text{ s}$ .                                                                                            | $q_{pd}$   | <5                | \      | \                 | pC         |
|                                      | Method a, after environmental tests subgroup 1, $V_{ini}=V_{IOTM}$ ,<br>$t_{ini}=60\text{ s}$ , $V_{pd(m)}=1.6*V_{IORM}$ ,<br>$t_m=10\text{ s}$                                                                                                     |            |                   |        |                   | pC         |
|                                      | Method b, routine test (100% production) and preconditioning (type test); $V_{ini}=1.2*V_{IOTM}$ ,<br>$t_{ini}=1\text{ s}$<br>$V_{pd(m)}=1.875*V_{IORM}$ ,<br>$t_m=1\text{ s}$ (method b1) or<br>$V_{pd(m)}=V_{ini}$ ,<br>$t_m=t_{ini}$ (method b2) |            |                   |        |                   | pC         |
| Apparent Charge                      | Method a, after Input/output safety test subgroup 2/3,<br>$V_{ini}=V_{IOTM}$ , $t_{ini}=60\text{ s}$ ,<br>$V_{pd(m)}=1.2*V_{IORM}$ , $t_m=10\text{ s}$ .                                                                                            | $q_{pd}$   | \                 | <5     | <5                | pC         |
|                                      | Method a, after environmental tests subgroup 1, $V_{ini}=V_{IOTM}$ ,<br>$t_{ini}=60\text{ s}$ , $V_{pd(m)}=1.3*V_{IORM}$ ,<br>$t_m=10\text{ s}$                                                                                                     |            |                   |        |                   | pC         |
|                                      | Method b, routine test (100% production) and preconditioning (type test); $V_{ini}=1.2*V_{IOTM}$ ,<br>$t_{ini}=1\text{ s}$<br>$V_{pd(m)}=1.5*V_{IORM}$ , $t_m=1\text{ s}$<br>(method b1) or                                                         |            |                   |        |                   | pC         |

| Description                         | Test Condition                                                                                                                           | Symbol     | Value             |            |                   | Unit       |
|-------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------|------------|-------------------|------------|-------------------|------------|
|                                     |                                                                                                                                          |            | SOP16<br>(600mil) | SSOP16     | SOP16<br>(150mil) |            |
|                                     | $V_{pd(m)}=V_{ini}$ ,<br>$t_m=t_{ini}$ (method b2)                                                                                       |            |                   |            |                   |            |
| Maximum transient isolation voltage | $t = 60 \text{ sec}$                                                                                                                     | $V_{IOTM}$ | 12000             | 5000       | 5000              | $V_{PEAK}$ |
| Maximum impulse voltage             | Tested in air, 1.2/50-us waveform per IEC62368-1                                                                                         | $V_{IMP}$  | 8000              | 5384       | 5384              | $V_{PEAK}$ |
| Maximum Surge Isolation Voltage     | Test method per IEC62368-1, 1.2/50us waveform, $V_{IOSM} \geq V_{IMP} \times 1.3$                                                        | $V_{IOSM}$ | 12800             | 7000       | 7000              | $V_{PEAK}$ |
| Isolation resistance                | $V_{IO} = 500V$ , $T_{amb}=25^{\circ}C$                                                                                                  | $R_{IO}$   | $>10^{12}$        | $>10^{12}$ | $>10^{12}$        | $\Omega$   |
|                                     | $V_{IO} = 500V$ , $100^{\circ}C \leq T_{amb} \leq 125^{\circ}C$                                                                          | $R_{IO}$   | $>10^{11}$        | $>10^{11}$ | $>10^{11}$        | $\Omega$   |
|                                     | $V_{IO} = 500V$ , $T_{amb}=T_s$                                                                                                          | $R_{IO}$   | $>10^9$           | $>10^9$    | $>10^9$           | $\Omega$   |
| Isolation capacitance               | $f = 1MHz$                                                                                                                               | $C_{IO}$   | 0.8               | 0.8        | 0.8               | pF         |
| <b>UL1577</b>                       |                                                                                                                                          |            |                   |            |                   |            |
| Insulation voltage per UL           | $V_{TEST} = V_{ISO}$ , $t = 60 \text{ s}$ (qualification),<br>$V_{TEST} = 1.2 \times V_{ISO}$ , $t = 1 \text{ s}$ (100% production test) | $V_{ISO}$  | 8500              | 3000       | 3750              | $V_{RMS}$  |

### 6.3. Safety-Limiting Values

Reinforced isolation safety-limiting values as outlined in VDE-0884-11 of NSI823x-DSWWR (SOP16(600mil))

| Description                      | Test Condition                                                                                   | Value | Unit        |
|----------------------------------|--------------------------------------------------------------------------------------------------|-------|-------------|
| Safety Supply Power              | $R_{\theta JA} = 78.9^{\circ}C/W^{1)}$ , $T_J = 150^{\circ}C$ , $T_A = 25^{\circ}C$              | 1584  | mW          |
| Safety Supply Current            | $R_{\theta JA} = 78.9^{\circ}C/W^{1)}$ , $V_I = 5V$ , $T_J = 150^{\circ}C$ , $T_A = 25^{\circ}C$ | 316.8 | mA          |
| Safety Temperature <sup>2)</sup> |                                                                                                  | 150   | $^{\circ}C$ |

- 1) Calculate with the junction-to-air thermal resistance,  $R_{\theta JA}$ , of SOP16(SOP16(600mil)) package ([Thermal Information Table](#)) which is that of a device installed on a low effective thermal conductivity test board (1s) according to JESD51-3.
- 2) The maximum safety temperature has the same value as the maximum junction temperature ( $T_J$ ) specified for the device.

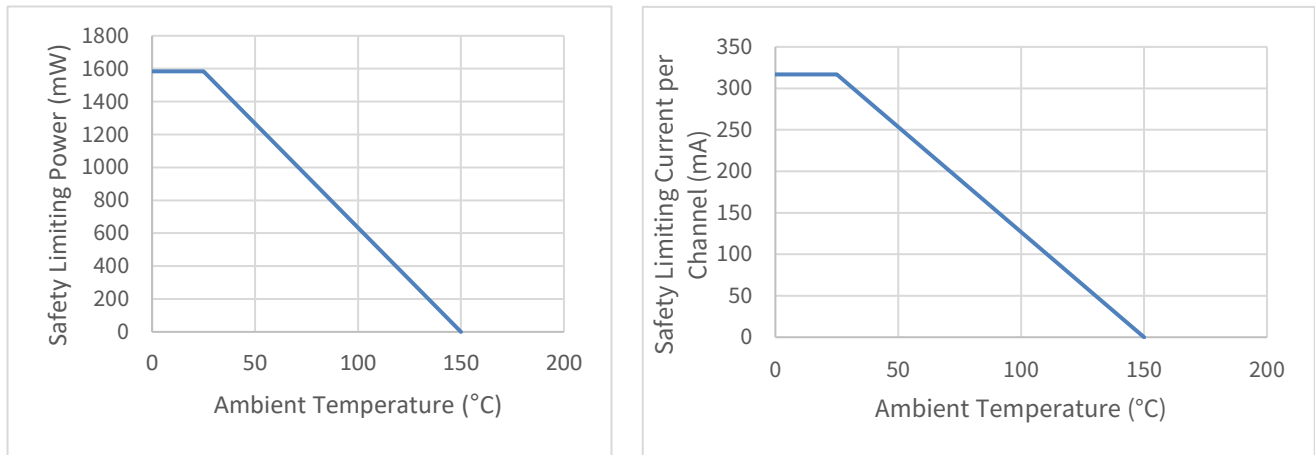


Figure 6.1 NSI823xW Thermal Derating Curve, Dependence of Safety Limiting Values with Case Temperature per DIN VDE V 0884-11

Basic isolation safety-limiting values as outlined in VDE-0884-11 of NSI823x-DSSR (SSOP16)

| Description                      | Test Condition                                                                                                               | Value | Unit |
|----------------------------------|------------------------------------------------------------------------------------------------------------------------------|-------|------|
| Safety Supply Power              | $R_{\theta JA} = 140^{\circ}\text{C/W}^{(1)}$ , $T_J = 150^{\circ}\text{C}$ , $T_A = 25^{\circ}\text{C}$                     | 880   | mW   |
| Safety Supply Current            | $R_{\theta JA} = 140^{\circ}\text{C/W}^{(1)}$ , $V_I = 5\text{V}$ , $T_J = 150^{\circ}\text{C}$ , $T_A = 25^{\circ}\text{C}$ | 176   | mA   |
| Safety Temperature <sup>2)</sup> |                                                                                                                              | 150   | °C   |

- 1) Calculate with the junction-to-air thermal resistance,  $R_{\theta JA}$ , of SSOP16 package ([Thermal Information Table](#)) which is that of a device installed on a low effective thermal conductivity test board (1s) according to JESD51-3.
- 2) The maximum safety temperature has the same value as the maximum junction temperature ( $T_J$ ) specified for the device.

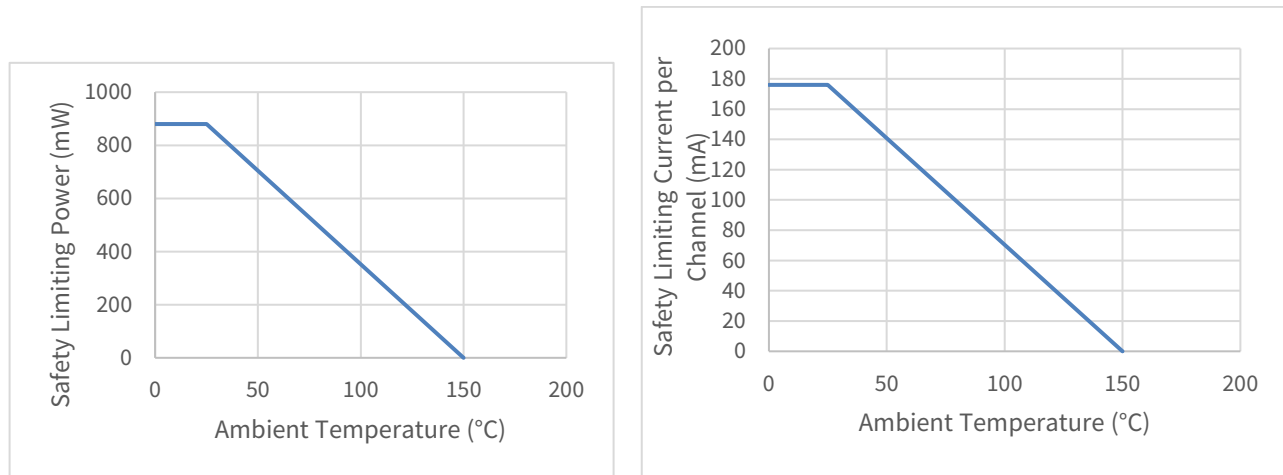


Figure 6.2 NSI823xS Thermal derating Curve, Dependence of Safety Limiting Values with Case Temperature per DIN VDE V 0884-11

Basic isolation safety-limiting values as outlined in VDE-0884-11 of NSI823x-DSPNR (SOP16)

| Description                      | Test Condition                                                                                                                | Value | Unit               |
|----------------------------------|-------------------------------------------------------------------------------------------------------------------------------|-------|--------------------|
| Safety Supply Power              | $R_{\theta JA} = 78.9^{\circ}\text{C/W}^{(1)}$ , $T_J = 150^{\circ}\text{C}$ , $T_A = 25^{\circ}\text{C}$                     | 1584  | mW                 |
| Safety Supply Current            | $R_{\theta JA} = 78.9^{\circ}\text{C/W}^{(1)}$ , $V_I = 5\text{V}$ , $T_J = 150^{\circ}\text{C}$ , $T_A = 25^{\circ}\text{C}$ | 316   | mA                 |
| Safety Temperature <sup>2)</sup> |                                                                                                                               | 150   | $^{\circ}\text{C}$ |

- 1) Calculate with the junction-to-air thermal resistance,  $R_{\theta JA}$ , of SOP16(150mil) package ([Thermal Information Table](#)) which is that of a device installed on a low effective thermal conductivity test board (1s) according to JESD51-3.
- 2) The maximum safety temperature has the same value as the maximum junction temperature ( $T_J$ ) specified for the device.

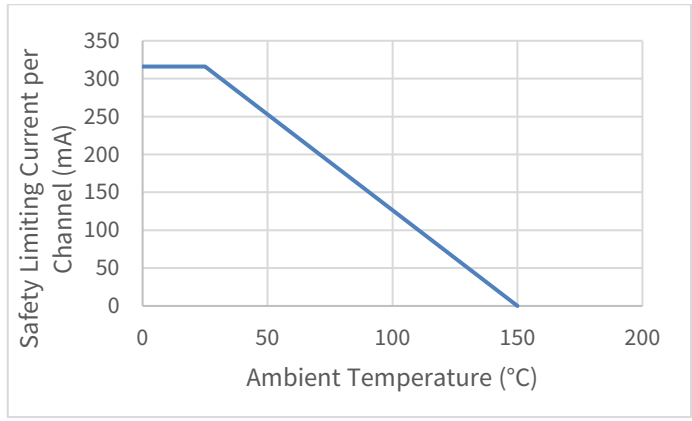
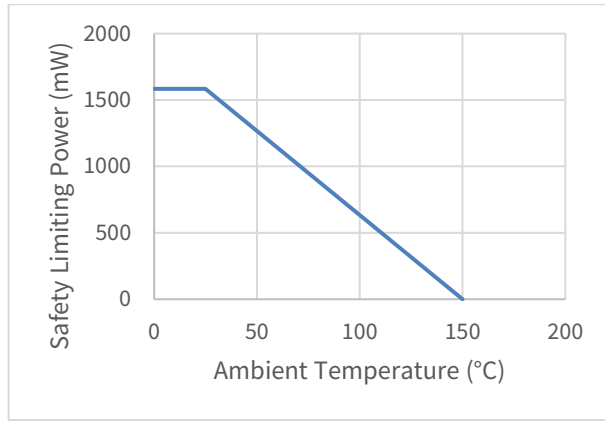


Figure 6.3 NSI823xN Thermal derating Curve, Dependence of Safety Limiting Values with Case Temperature per DIN VDE V 0884-11

## 6.4. Regulatory Information

The NSI823xWx-DSWWR are approved or pending approval by the organizations listed in table.

| CUL                                                       |                                                           | VDE                                                                                                                  | CQC                                  | TUV                                   |
|-----------------------------------------------------------|-----------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------|--------------------------------------|---------------------------------------|
| UL 1577 Component Recognition Program                     | Approved under CSA Component Acceptance Notice 5A         | DIN EN IEC 60747-17 (VDE 0884-17)                                                                                    | Certified according to GB4943.1-2022 | Certified According to EN IEC 62368-1 |
| Single Protection, 8500V <sub>rms</sub> Isolation voltage | Single Protection, 8500V <sub>rms</sub> Isolation voltage | Reinforced Insulation<br>$V_{IORM}=2121\text{Vpeak}$<br>$V_{IOTM}=12000\text{Vpeak}$<br>$V_{IOSM}=12800\text{Vpeak}$ | Reinforced insulation                | 5000Vrms for 1min                     |
| E500602                                                   | E500602                                                   | 40052820                                                                                                             | CQC23001379406                       | R50574061                             |

The NSI823xSx-DSSR are approved or pending approval by the organizations listed in table.

| <b>CUL</b>                                                |                                                           | <b>VDE</b>                                                                                                                                          | <b>CQC</b>                           | <b>TUV</b>                            |
|-----------------------------------------------------------|-----------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------|---------------------------------------|
| UL 1577 Component Recognition Program                     | Approved under CSA Component Acceptance Notice 5A         | DIN EN IEC 60747-17 (VDE 0884-17)                                                                                                                   | Certified according to GB4943.1-2022 | Certified According to EN IEC 62368-1 |
| Single Protection, 3000V <sub>rms</sub> Isolation voltage | Single Protection, 3000V <sub>rms</sub> Isolation voltage | Basic Insulation<br>V <sub>IORM</sub> =565V <sub>peak</sub><br>V <sub>IOTM</sub> =5000V <sub>peak</sub><br>V <sub>IOSM</sub> =7000V <sub>peak</sub> | Basic insulation                     | 5000Vrms for 1min                     |
| E500602                                                   | E500602                                                   | 40057024                                                                                                                                            | CQC23001391258                       | R50574061                             |

The NSI823xNx-DSPNR are approved or pending approval by the organizations listed in table.

| <b>CUL</b>                                                |                                                           | <b>VDE</b>                                                                                                                                          | <b>CQC</b>                           | <b>TUV</b>                            |
|-----------------------------------------------------------|-----------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------|---------------------------------------|
| UL 1577 Component Recognition Program                     | Approved under CSA Component Acceptance Notice 5A         | DIN EN IEC 60747-17 (VDE 0884-17)                                                                                                                   | Certified according to GB4943.1-2022 | Certified According to EN IEC 62368-1 |
| Single Protection, 3750V <sub>rms</sub> Isolation voltage | Single Protection, 3750V <sub>rms</sub> Isolation voltage | Basic Insulation<br>V <sub>IORM</sub> =565V <sub>peak</sub><br>V <sub>IOTM</sub> =5000V <sub>peak</sub><br>V <sub>IOSM</sub> =7000V <sub>peak</sub> | Basic insulation                     | 3000Vrms for 1min                     |
| E500602                                                   | E500602                                                   | 40057024                                                                                                                                            | CQC21001289931                       | R50574061                             |

## 7. Function Description

### 7.1. Overview

The NSI823x is a Triple-channel digital isolator based on a capacitive isolation barrier technique. The digital signal is modulated with RF carrier generated by the internal oscillator at the Transmitter side. Then it is transferred through the capacitive isolation barrier and demodulated at the Receiver side.

The NSI823x devices are high reliability Triple-channel digital isolator. The NSI823x device is safety certified by UL1577 support 5kV<sub>rms</sub> insulation withstand voltages, while providing high electromagnetic immunity and low emissions at low power consumption. The data rate of the NSI823x is up to 150Mbps, and the common-mode transient immunity (CMTI) is up to 250kV/us. The NSI823x device provides digital channel direction configuration and the default output level configuration when the input power is lost. Wide supply voltage of the NSI823x device support to connect with most digital interface directly, easy to do the level shift. High system level EMC performance enhance reliability and stability of use.

The NSI823x has a default output status when VDDIN is unready and VDDOUT is ready as shown in Table 7.1, which helps for diagnosis when power is missing at the transmitter side. The output B follows the same status with the input A after powering up.

Table 7.1 Output status vs. power status

| <i>Input<sup>1</sup></i>                                                                                                                                                                                                                                                                                                                                         | <i>ENx<sup>2</sup></i> | <i>VDD1 status</i> | <i>VDD2 status</i> | <i>Output</i>                | <i>Comment</i>                                                                          |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------|--------------------|--------------------|------------------------------|-----------------------------------------------------------------------------------------|
| H                                                                                                                                                                                                                                                                                                                                                                | H or NC                | Ready              | Ready              | H                            | Normal operation.                                                                       |
| L                                                                                                                                                                                                                                                                                                                                                                | H or NC                | Ready              | Ready              | L                            |                                                                                         |
| X                                                                                                                                                                                                                                                                                                                                                                | L                      | Ready              | Ready              | Z                            | Output Disabled, the output is high impedance                                           |
| X                                                                                                                                                                                                                                                                                                                                                                | H or NC                | Unready            | Ready              | L(NSI823xx0)<br>H(NSI823xx1) | The output follows the same status with the input after input side VDD is powered on.   |
| X                                                                                                                                                                                                                                                                                                                                                                | L                      | Unready            | Ready              | Z                            | Output Disabled, the output is high impedance                                           |
| X                                                                                                                                                                                                                                                                                                                                                                | X                      | Ready              | Unready            | Undetermined                 | The output follows the same status with the input after output side VDD2 is powered on. |
| <p>Note: H=Logic high; L=Logic low; X=Logic low or logic high<br/>VDD1 is input side power; VDD2 is outside power.</p> <p>(1) There is a protection diode between the input and the VDDIN. When the VDDIN is floating, the strong drive signal through the input pin will put the VDDIN in an indeterminate state.</p> <p>(2) The ENx is output side enable.</p> |                        |                    |                    |                              |                                                                                         |

## 7.2. OOK Modulation

NSI823x is based on a capacitive isolation barrier technique and the digital signal is modulated with RF carrier generated by the internal oscillator at the transmitter side, as shown in Figure 7.1 to Figure 7.2, then it is transferred through the capacitive isolation barrier and demodulated at the receiver side. The modulation uses OOK modulation technique with key benefits of high noise immunity and low radiation EMI.

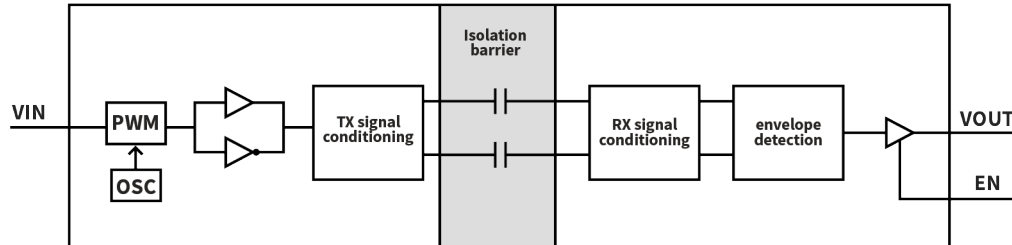


Figure 7.1 Single Channel Function Block Diagram

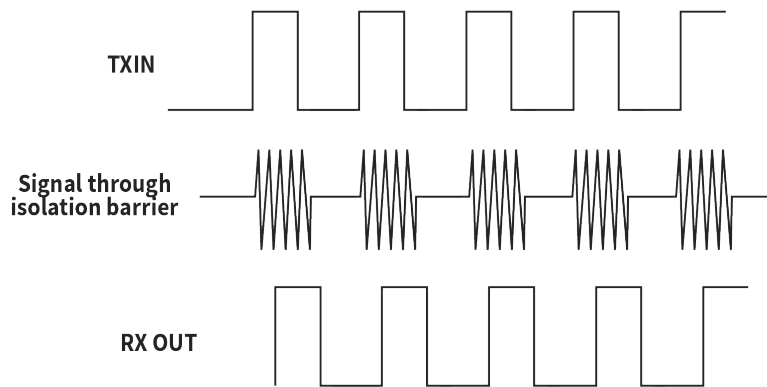


Figure 7.2 OOK Modulation

## 8. Application Note

### 8.1. Typical Application Circuit

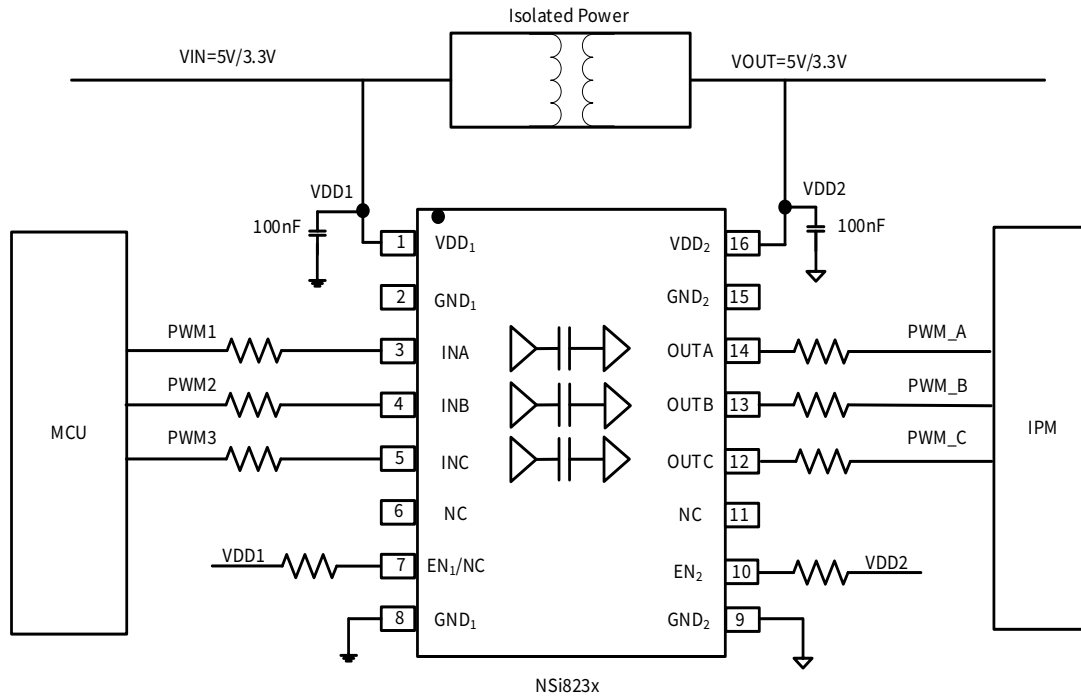


Figure 8.1 Typical PWM isolation circuit for IPM

### 8.2. PCB Layout

The NSI823x requires a 0.1  $\mu\text{F}$  bypass capacitor between VDD1 and GND1, VDD2 and GND2. The capacitor should be placed as close as possible to the package. Figure 8.2 to Figure 8.3 show the recommended PCB layout, make sure the space under the chip should keep free from planes, traces, pads and via. To enhance the robustness of a design, the user may also include resistors (50–300  $\Omega$ ) in series with the inputs and outputs if the system is excessively noisy. The series resistors also improve the system reliability such as latch-up immunity.

The typical output impedance of an isolator driver channel is approximately 50  $\Omega$ ,  $\pm 40\%$ . When driving loads where transmission line effects will be a factor, output pins should be appropriately terminated with controlled impedance PCB traces.

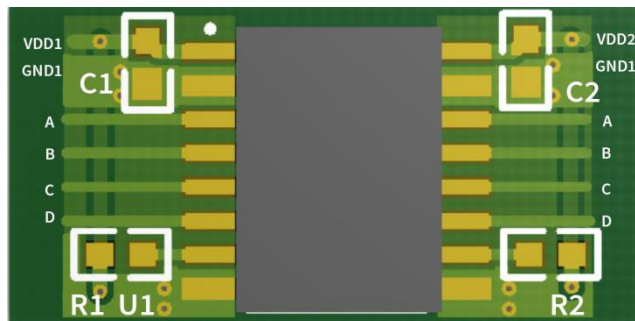


Figure8.2 Recommended PCB Layout — Top Layer



Figure8.3 Recommended PCB Layout — Bottom Layer

### 8.3. High Speed Performance

Figure 8.4 shows the eye diagram of NSI823x at 50Mbps data rate output. The result shows a typical measurement on NSI823x with low jitter and wide open eye characteristics.

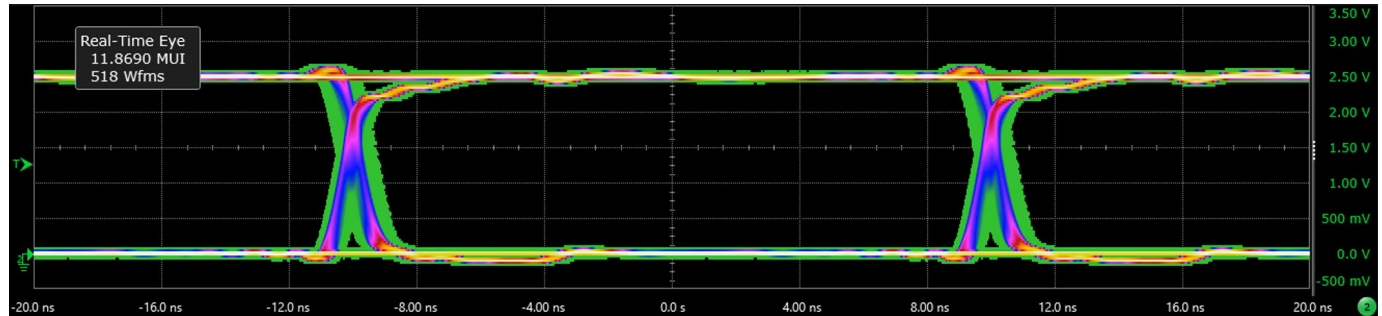


Figure 8.4 Eye Diagram at 50Mbps PRBS 2<sup>16</sup>-1, 2.5V and 25°C

### 8.4. Typical Supply Current Equations

The typical supply current of NSI823x can be calculated using below equations.  $I_{DD1}$  and  $I_{DD2}$  are typical supply currents measured in mA,  $f$  is data rate measured in Mbps,  $C_L$  is the capacitive load measured in pF

#### NSI8230:

$$I_{DD1} = 0.19 \cdot a1 + 1.45 \cdot b1 + 0.82 \cdot c1.$$

$$I_{DD2} = 1.36 + VDD2 \cdot f \cdot C_L \cdot c1 \cdot 10^{-9}$$

When  $a1$  is the channel number of low input at side 1,  $b1$  is the channel number of high input at side 1,  $c1$  is the channel number of switch signal input at side 1.

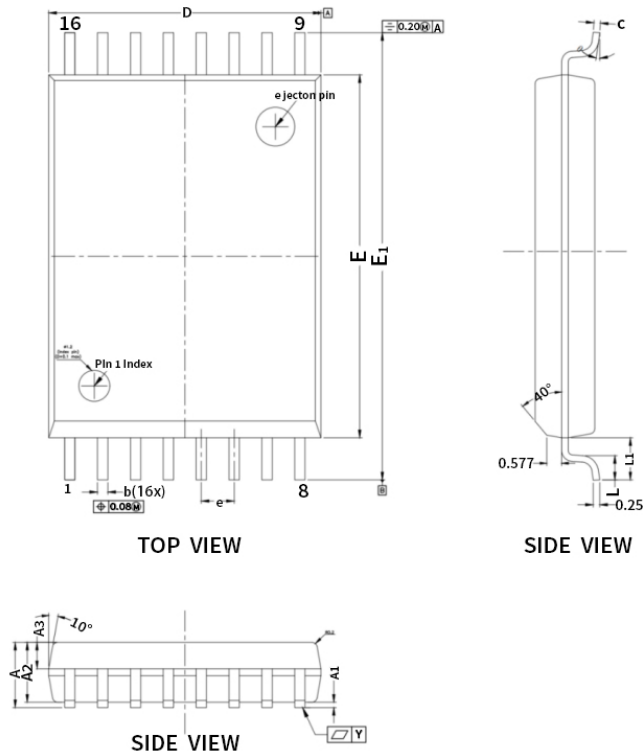
#### NSI8231:

$$I_{DD1} = 0.87 + 1.26 \cdot b1 + 0.63 \cdot c1 + VDD1 \cdot f \cdot C_L \cdot c2 \cdot 10^{-9}$$

$$I_{DD2} = 0.87 + 1.26 \cdot b2 + 0.63 \cdot c2 + VDD2 \cdot f \cdot C_L \cdot c1 \cdot 10^{-9}$$

When  $b1$  is the channel number of high input at side 1,  $c1$  is the channel number of switch signal input at side 1,  $b2$  is the channel number of high input at side 2,  $c2$  is the channel number of switch signal input at side 2.

## 9. Package Information



### \* CONTROLLING DIMENSION:MM

| SYMBOL | MILLIMETER |       |       |
|--------|------------|-------|-------|
|        | MIN.       | NOM.  | MAX.  |
| A      | ---        | ---   | 2.65  |
| A1     | 0.10       | ---   | 0.30  |
| A2     | 2.25       | 2.30  | 2.35  |
| A3     | 0.97       | 1.02  | 1.07  |
| b      | 0.35       | ---   | 0.43  |
| c      | 0.23       | ---   | 0.32  |
| D      | 10.42      | 10.52 | 10.62 |
| E      | 13.9       | 14.0  | 14.1  |
| E1     | 17.1       | ---   | 17.4  |
| e      | 1.27 bsc   |       |       |
| L1     | 1.625 bsc  |       |       |
| L      | 0.6        | ---   | 1.1   |
| Y      | ---        | 0.10  | ---   |
| θ      | 0°         | ---   | 8°    |

### NOTES

1.0 COPWARTY APPUES TO LEADS, CORNER LEADS AND DIE ATTACH PAD.

Figure 9.1 SOP16(600mil)/SOWW16 Package Shape and Dimension in millimeters

NOTE: This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.

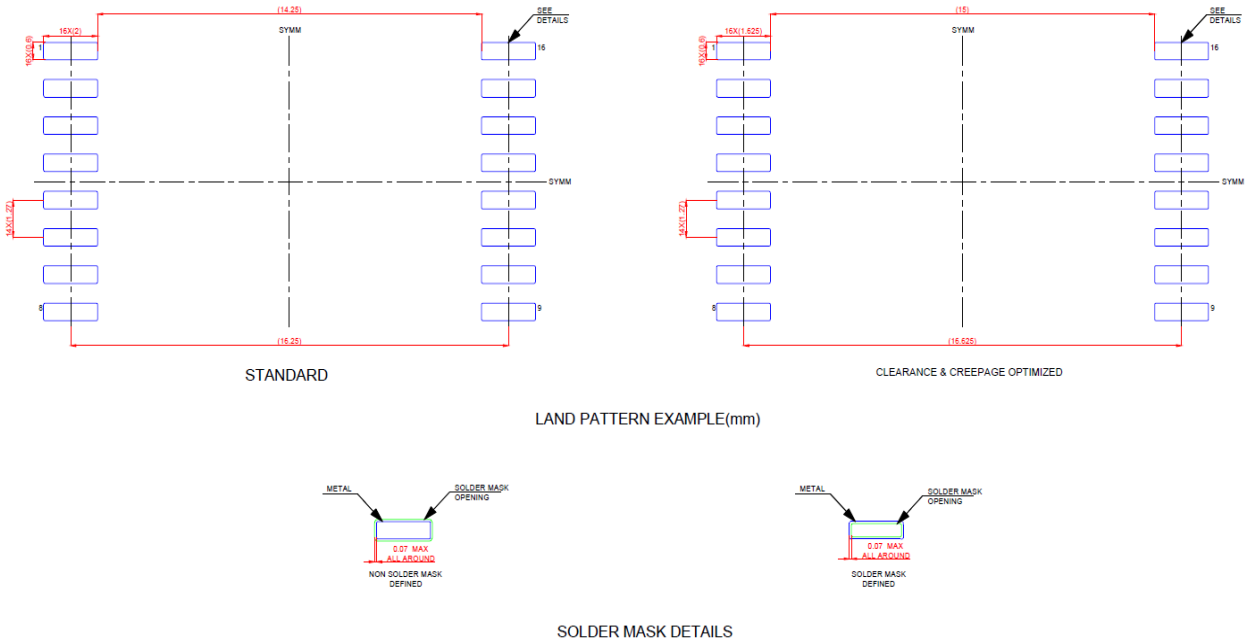
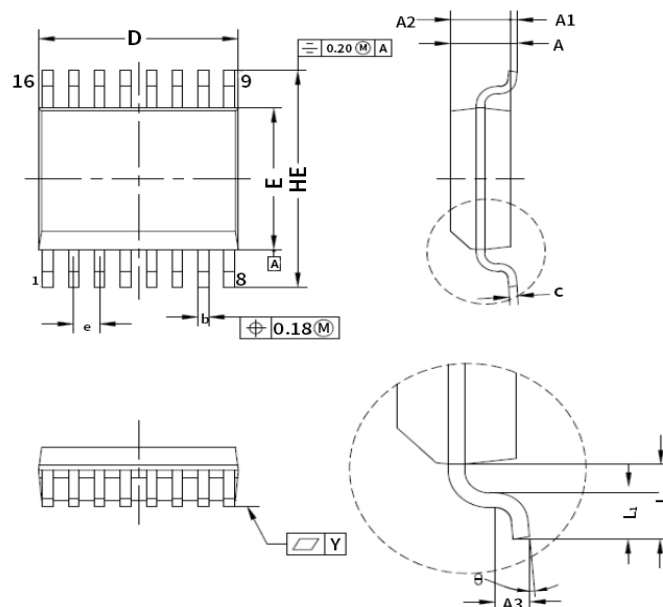


Figure 9.2 SOP16(600mil)/SOWW16 Package Board Layout Example

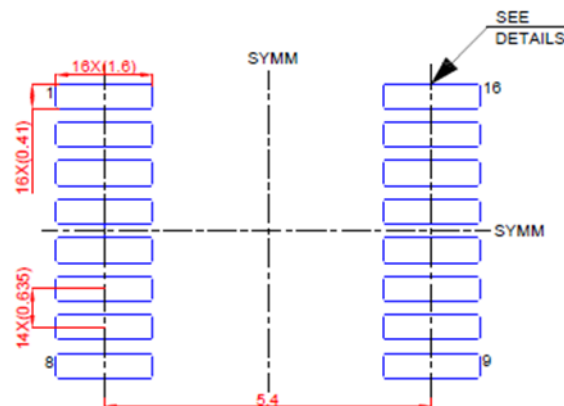


\* CONTROLLING DIMENSION:MM

| SYMBOL | MILLIMETER |      |      | INCH      |       |       |
|--------|------------|------|------|-----------|-------|-------|
|        | MIN.       | NOM. | MAX. | MIN.      | NOM.  | MAX.  |
| A      | ---        | ---  | 1.73 | ---       | ---   | 0.068 |
| A1     | 0.10       | ---  | 0.25 | 0.004     | ---   | 0.010 |
| A2     | 1.40       | ---  | 1.55 | 0.055     | ---   | 0.061 |
| b      | 0.20       | ---  | 0.31 | 0.008     | ---   | 0.012 |
| c      | 0.18       | ---  | 0.25 | 0.007     | ---   | 0.010 |
| D      | 4.80       | ---  | 5.00 | 0.189     | ---   | 0.197 |
| E      | 3.80       | ---  | 4.00 | 0.150     | ---   | 0.157 |
| HE     | 5.80       | ---  | 6.20 | 0.228     | ---   | 0.244 |
| e      | 0.635 bsc  |      |      | 0.025 bsc |       |       |
| L      | 1.00 bsc   |      |      | 0.039 bsc |       |       |
| L1     | 0.41       | ---  | 0.89 | 0.016     | ---   | 0.035 |
| Y      | ---        | 0.09 | ---  | ---       | 0.004 | ---   |
| A3     | ---        | 0.25 | ---  | ---       | 0.010 | ---   |
| θ      | 0°         | ---  | 8°   | 0°        | ---   | 8°    |

Figure 9.3 SSOP16 Package Shape and Dimension in millimeters

NOTE: This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.



LAND PATTERN EXAMPLE(mm)

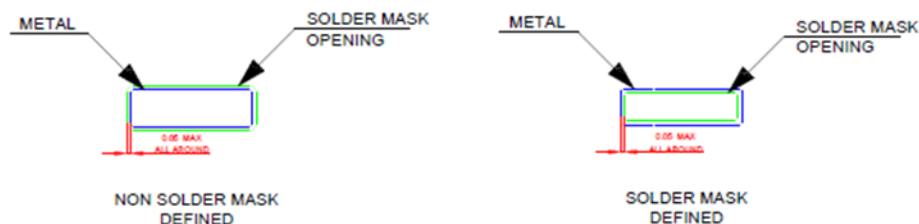


Figure 9.4 SSOP16 Package Board Layout Example

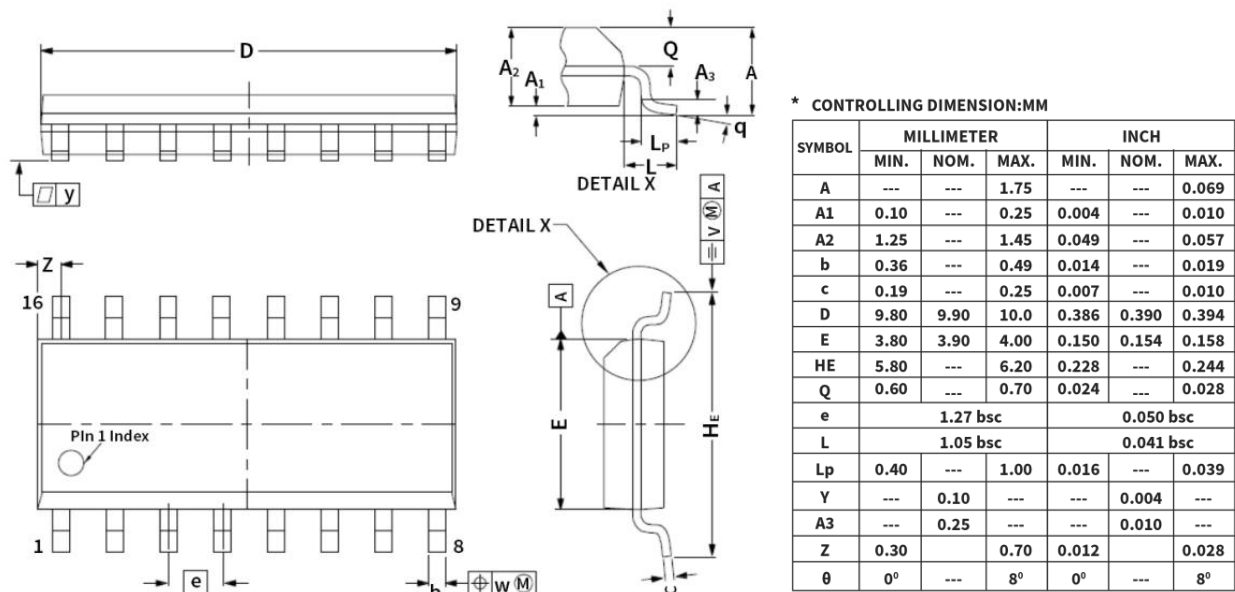
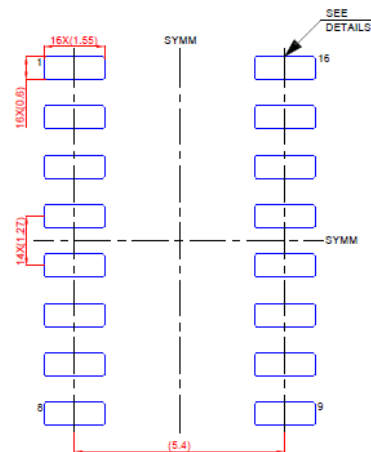
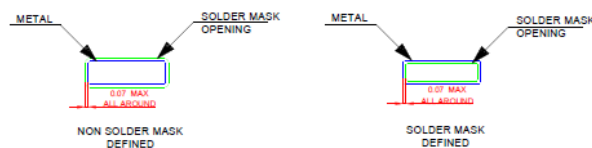


Figure 9.5 SOP16(150mil) Package Shape and Dimension in millimeters

NOTE: This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.



LAND PATTERN EXAMPLE(mm)



SOLDER MASK DETAILS

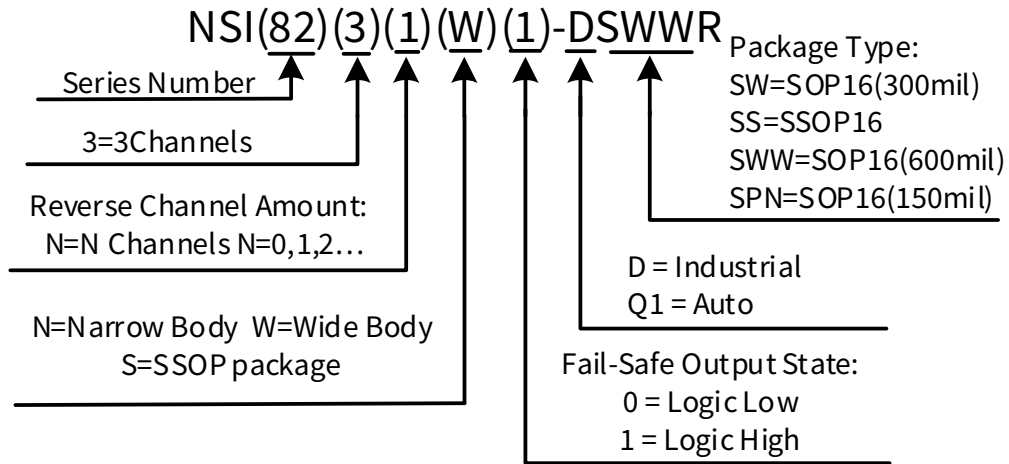
Figure 9.6 SOP16(150mil) Package Board Layout Example

## 10. Order Information

| <i>Part Number</i> | <i>Isolation Rating (kV)</i> | <i>Number of side 1 inputs</i> | <i>Number of side 2 inputs</i> | <i>Max Data Rate (Mbps)</i> | <i>Default Output State</i> | <i>Temperature</i> | <i>MSL</i> | <i>Package Type</i> | <i>Package Drawing</i> | <i>SPQ</i> |
|--------------------|------------------------------|--------------------------------|--------------------------------|-----------------------------|-----------------------------|--------------------|------------|---------------------|------------------------|------------|
| NSI8230W0-DSWWR    | 8                            | 3                              | 0                              | 150                         | Low                         | -55 to 125°C       | 3          | SOP16 (600mil)      | SOWW16                 | 1000       |
| NSI8230W1-DSWWR    | 8                            | 3                              | 0                              | 150                         | High                        | -55 to 125°C       | 3          | SOP16 (600mil)      | SOWW16                 | 1000       |
| NSI8231W0-DSWWR    | 8                            | 2                              | 1                              | 150                         | Low                         | -55 to 125°C       | 3          | SOP16 (600mil)      | SOWW16                 | 1000       |
| NSI8231W1-DSWWR    | 8                            | 2                              | 1                              | 150                         | High                        | -55 to 125°C       | 3          | SOP16 (600mil)      | SOWW16                 | 1000       |
| NSI8230S0-DSSR     | 3                            | 3                              | 0                              | 150                         | Low                         | -55 to 125°C       | 1          | SSOP16              | SSOP16                 | 2500       |
| NSI8230S1-DSSR     | 3                            | 3                              | 0                              | 150                         | High                        | -55 to 125°C       | 1          | SSOP16              | SSOP16                 | 2500       |
| NSI8231S0-DSSR     | 3                            | 2                              | 1                              | 150                         | Low                         | -55 to 125°C       | 1          | SSOP16              | SSOP16                 | 2500       |
| NSI8231S1-DSSR     | 3                            | 2                              | 1                              | 150                         | High                        | -55 to 125°C       | 1          | SSOP16              | SSOP16                 | 2500       |
| NSI8230N0-DSPNR    | 3                            | 3                              | 0                              | 150                         | Low                         | -55 to 125°C       | 1          | SOP16 (150mil)      | SOP16                  | 2500       |
| NSI8230N1-DSPNR    | 3                            | 3                              | 0                              | 150                         | High                        | -55 to 125°C       | 1          | SOP16 (150mil)      | SOP16                  | 2500       |
| NSI8231N0-DSPNR    | 3                            | 2                              | 1                              | 150                         | Low                         | -55 to 125°C       | 1          | SOP16 (150mil)      | SOP16                  | 2500       |
| NSI8231N1-DSPNR    | 3                            | 2                              | 1                              | 150                         | High                        | -55 to 125°C       | 1          | SOP16 (150mil)      | SOP16                  | 2500       |

NOTE: All packages are RoHS-compliant with peak reflow temperatures of 260 °C according to the JEDEC industry standard classifications and peak solder temperatures.

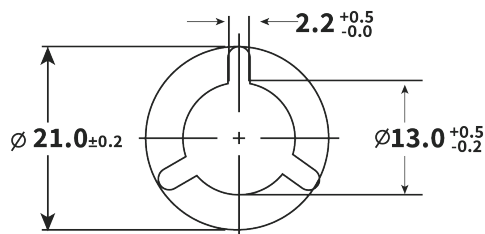
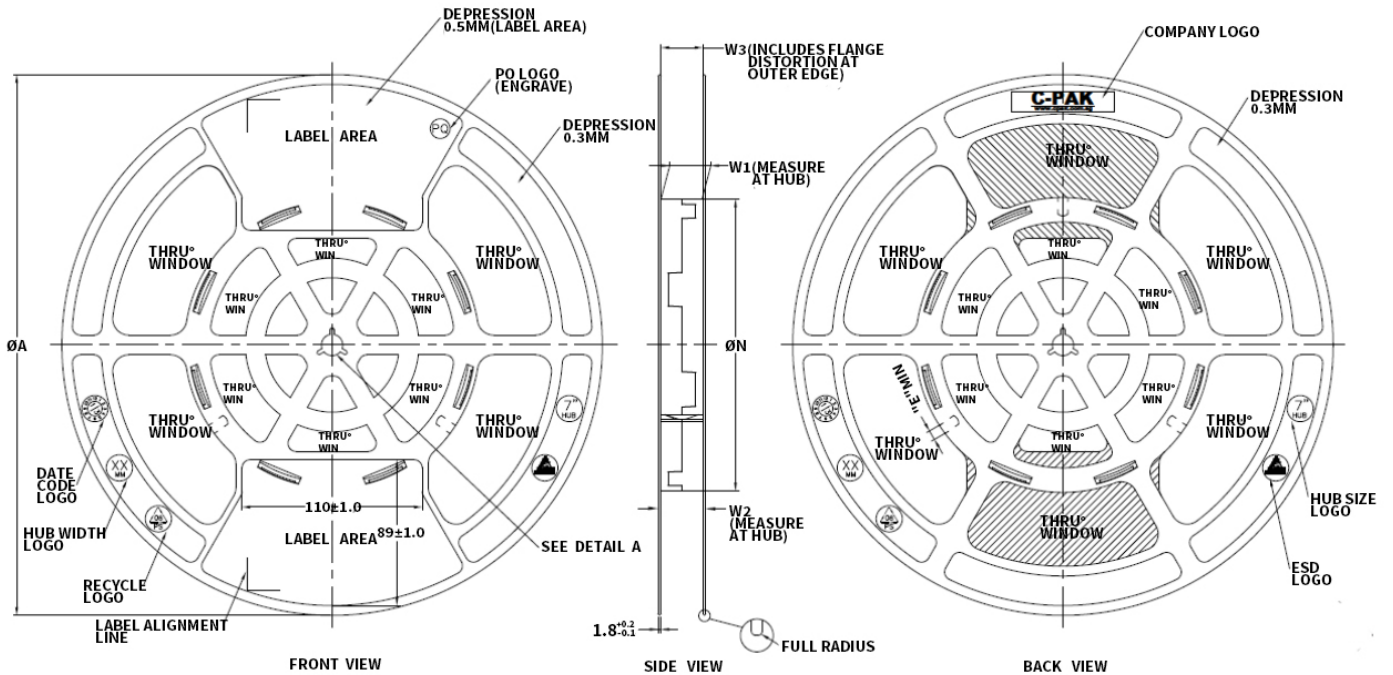
**Part Number Rule:**



## 11. Documentation Support

| Part Number | Product Folder | Datasheet | Technical Documents | Isolator selection guide |
|-------------|----------------|-----------|---------------------|--------------------------|
| NSI823x     | tbd            | tbd       | tbd                 | tbd                      |

## 12. Tape and Reel Information



**ARBOR HOLE  
DETAIL A  
SCALE: 3:1**

| PRODUCT SPECIFICATION |             |             |                                      |             |                                                               |            |
|-----------------------|-------------|-------------|--------------------------------------|-------------|---------------------------------------------------------------|------------|
| TAPE WIDTH            | Ø A<br>±2.0 | Ø N<br>±2.0 | W1                                   | W2<br>(Max) | W3                                                            | E<br>(MIN) |
| 08MM                  | 330         | 178         | 8.4 <sup>+1.5</sup> <sub>-0.0</sub>  | 14.4        | SHALL<br>ACCOMMODATE<br>TAPE WIDTH<br>WITHOUT<br>INTERFERENCE | 5.5        |
| 12MM                  | 330         | 178         | 12.4 <sup>+2.0</sup> <sub>-0.0</sub> | 18.4        |                                                               | 5.5        |
| 16MM                  | 330         | 178         | 16.4 <sup>+2.0</sup> <sub>-0.0</sub> | 22.4        |                                                               | 5.5        |
| 24MM                  | 330         | 178         | 24.4 <sup>+2.0</sup> <sub>-0.0</sub> | 30.4        |                                                               | 5.5        |
| 32MM                  | 330         | 178         | 32.4 <sup>+2.0</sup> <sub>-0.0</sub> | 38.4        |                                                               | 5.5        |

| SURFACE RESISTIVITY |                                         |                     |            |
|---------------------|-----------------------------------------|---------------------|------------|
| LEGEND              | SR RANGE                                | TYPE                | COLOUR     |
| A                   | BELOW 10 <sup>12</sup>                  | ANTISTATIC          | ALL TYPES  |
| B                   | 10 <sup>6</sup> TO 10 <sup>11</sup>     | STATIC DISSIPATIVE  | BLACK ONLY |
| C                   | 10 <sup>5</sup> & BELOW 10 <sup>5</sup> | CONDUCTIVE(GENERIC) | BLACK ONLY |
| E                   | 10 <sup>9</sup> TO 10 <sup>11</sup>     | ANTISTATIC(COATED)  | ALL TYPES  |

Figure 12.1 Reel Information (for all packages)

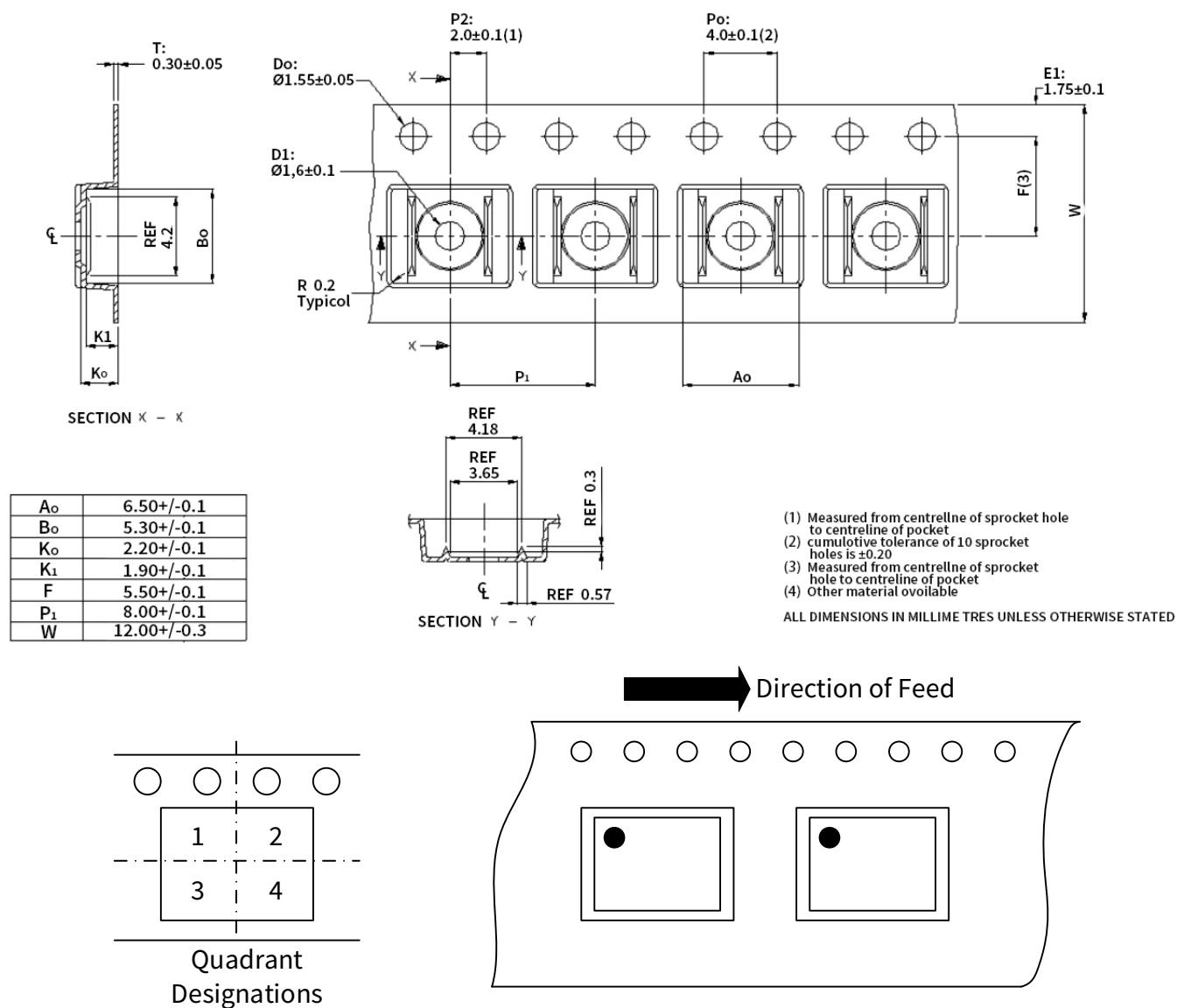
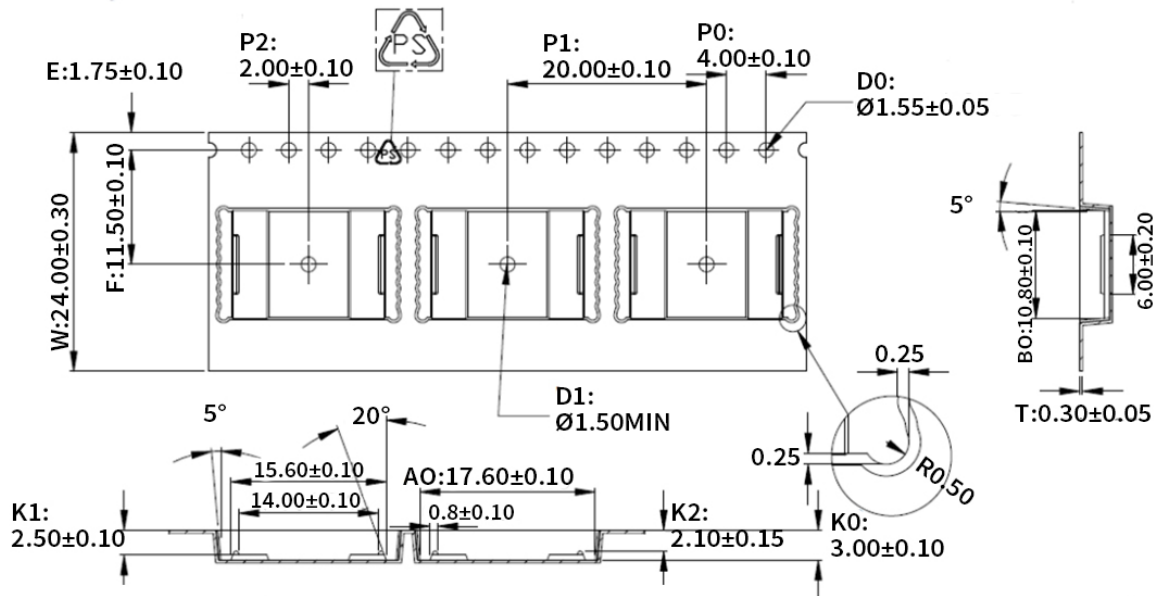


Figure 12.2 Tape Information of SSOP16



1. 10 sprocket hole pitch cumulative tolerance  $\pm 0.20$ .
2. Carrier camber is within 1 mm in 250 mm.
3. Material : Black Conductive Polystyrene Alloy.
4. All dimensions meet EIA-481 requirements.
5. Thickness:  $0.30 \pm 0.05 \text{ mm}$ .
6. Packing length per 19" reel: 246.0 Meters. (Rewind 1:13 )
7. Component load per 13" reel: 5000 pcs.
8. Surface resistivity:  $10^5 \sim 10^{10} \Omega / \square$

|    |                  |
|----|------------------|
| W  | $24.00 \pm 0.30$ |
| A0 | $17.60 \pm 0.10$ |
| B0 | $10.80 \pm 0.10$ |
| K0 | $3.00 \pm 0.10$  |
| K1 | $2.50 \pm 0.10$  |

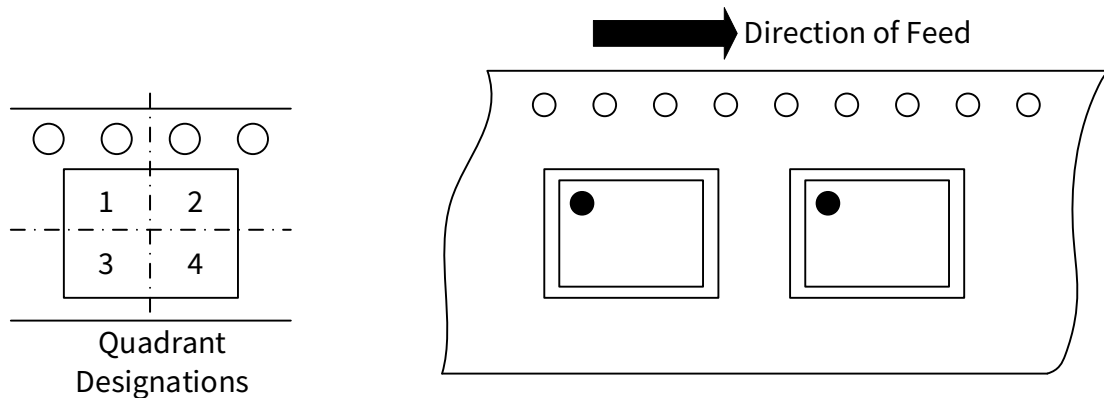


Figure 12.3 Tape Information of SOP16(600mil)

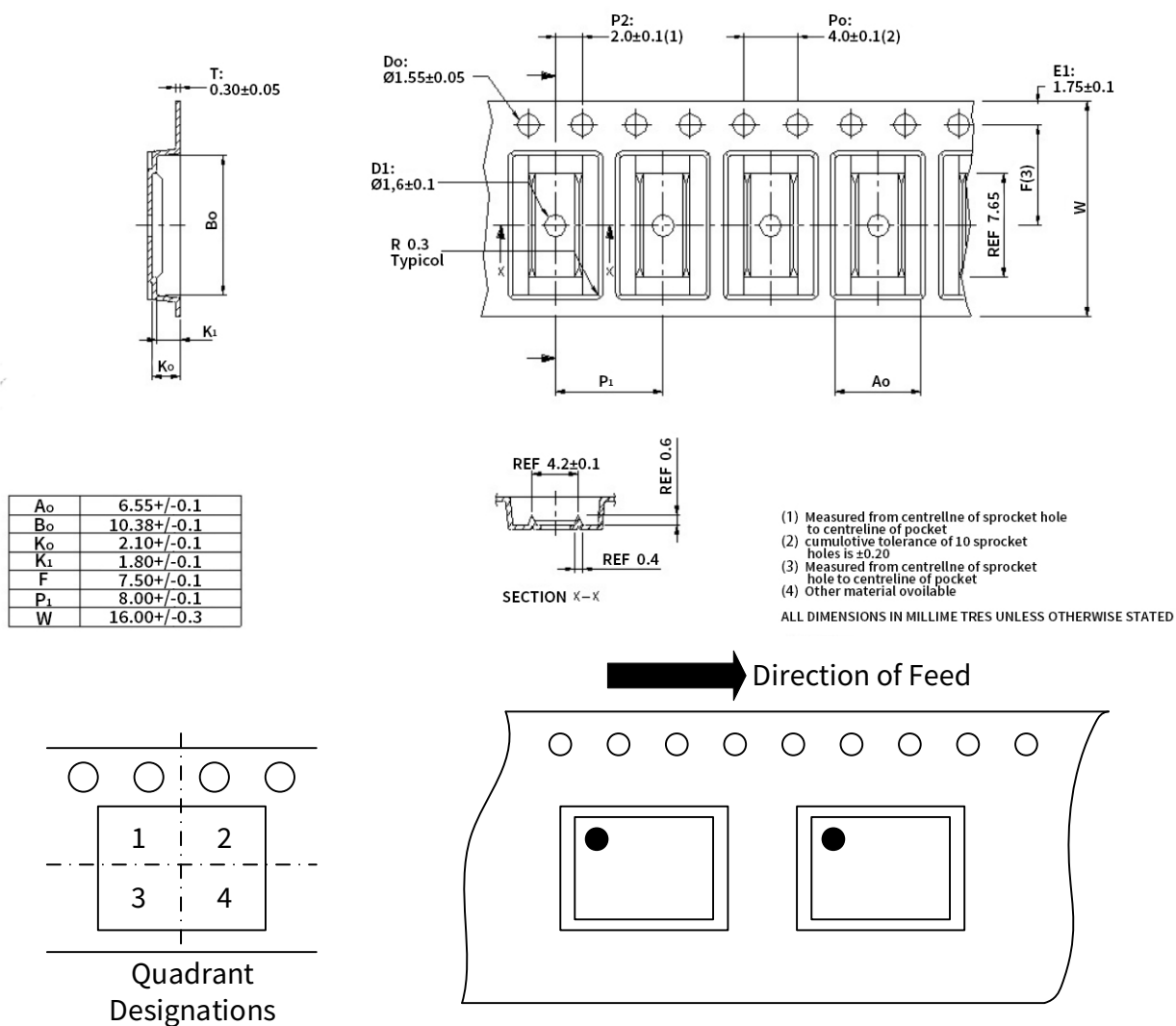


Figure 12.4 Tape Information of SOP16(150mil)

### 13. Revision history

| Revision | Description                                                                                                                                                                                                            | Date       |
|----------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------|
| 1.0      | Initial version                                                                                                                                                                                                        | 2020/11/20 |
| 1.1      | Changed tape and reel information, changed format.                                                                                                                                                                     | 2021/2/4   |
| 1.2      | Operating temperature support -55 to 125°C                                                                                                                                                                             | 2021/7/7   |
| 1.3      | Add SSOP16 and SOP16 package. Update Part Number Rule, Package Board Layout Example. Update SOWW16 VISO.                                                                                                               | 2022/8/16  |
| 1.4      | Update SOWW16 body size, CQC certification version                                                                                                                                                                     | 2023/2/14  |
| 1.5      | Correct formatting and images. Delete NSI823xBWx. Update Input characteristics. Update Safety certification info throughout the document. Update eye diagram. Update Package Information. Update Function Description. | 2025/1/21  |
| 1.6      | Delete SOP16(300mil) package products.                                                                                                                                                                                 | 2025/12/10 |

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